

Position Sensitive Detectors and Applications

at CIAE

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Science and Technology

on Nuclear Data Laboratory

China Institute of Atomic Energy

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Outline

- **Developments of Advanced Gas Detectors**
 - **R&D of GEM at CIAE**
 - **R&D of MicroMegas at CIAE**
 - **R&D of RPC at CIAE**
- **Developments of EMCal Detectors for sPHENIX**
- **ALICE Upgrade**
- **Summary and Perspective**

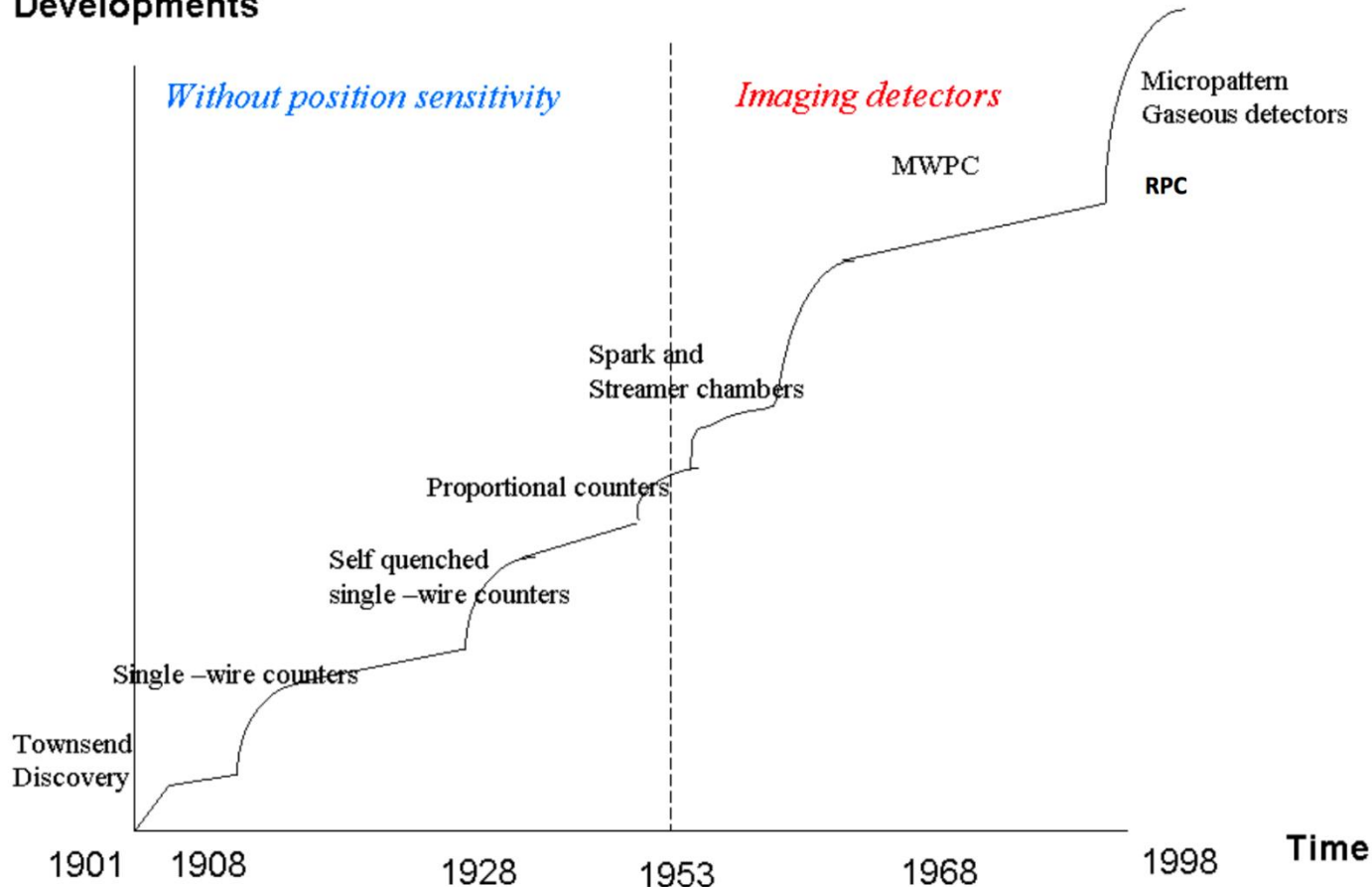


Developments of Advanced Gas Detectors



Developments of Gas Detectors

Developments



Recent High Rate and High Precision Experiments require better detectors.



Advanced Gas Detectors

- **Micro-Pattern Gaseous Detector (MPGD) :**
GEM
MicroMegas
- **Resistive Plate Detector(RPC):**
RPC
MRPC

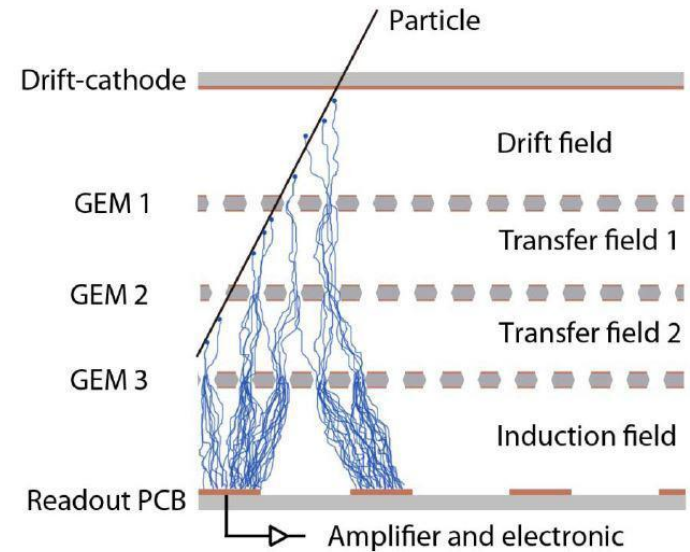
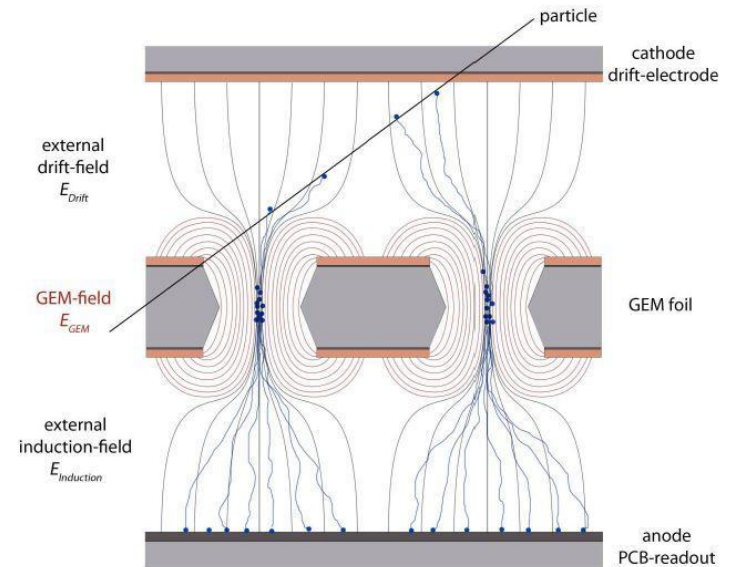


R&D of GEM at CIAE



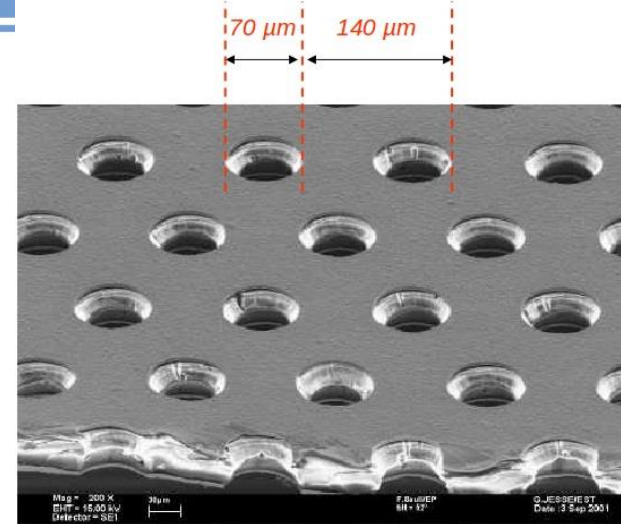
Structure of GEM

- **GEM detector:**
 - Cathode, Drift field, GEM foil, Induction field and Readout board.
 - **GEM foil: the most important part of GEM detector . Normally 3 GEM foils in one GEM detector.**

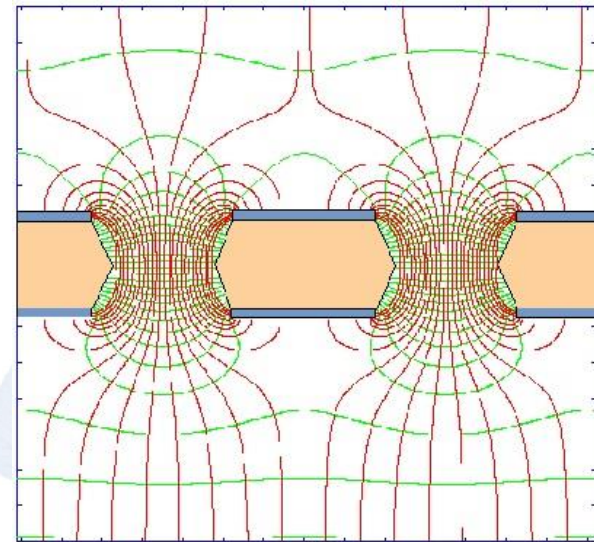


GEM Foil

1. Typical GEM Foil has 3 layers, two $5\mu\text{m}$ thick copper foils and one $50\mu\text{m}$ thick kapton foil in the middle.
2. Diameter of the hole is $70\mu\text{m}$, and the distance between them is $140\mu\text{m}$.
3. Apply electric voltages on the two copper layers.
4. Electric Field is very strong in the hole area, and weak outside the hole area.



GEM Foil

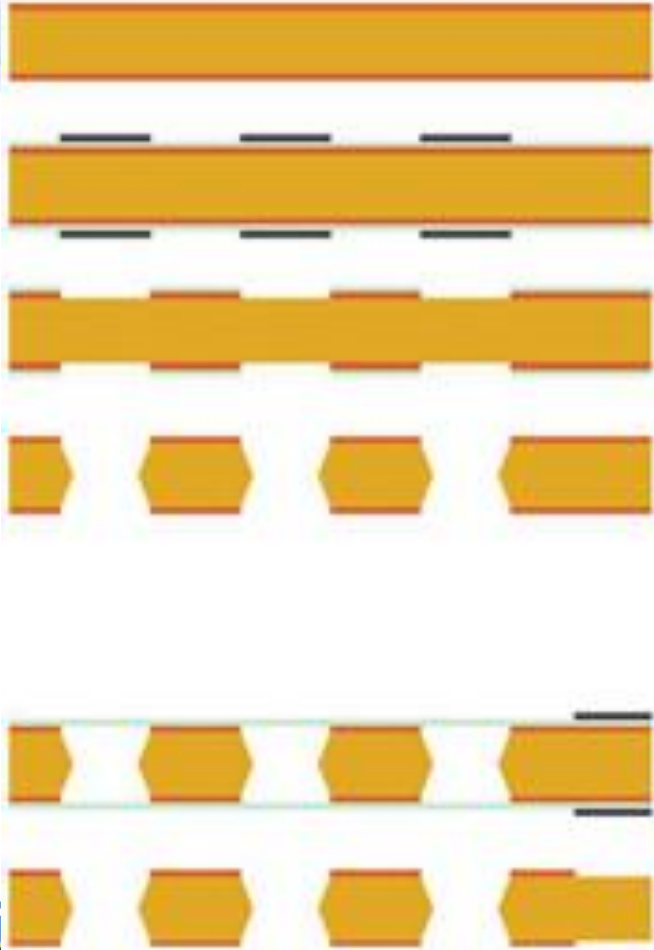


GEM Field



The Procedure of GEM Foil

Double mask photolithography



50 μm kapton foil 5 μm copper clad on both sides

Photoresist coating, masking, exposure

Photoresist development, copper etching

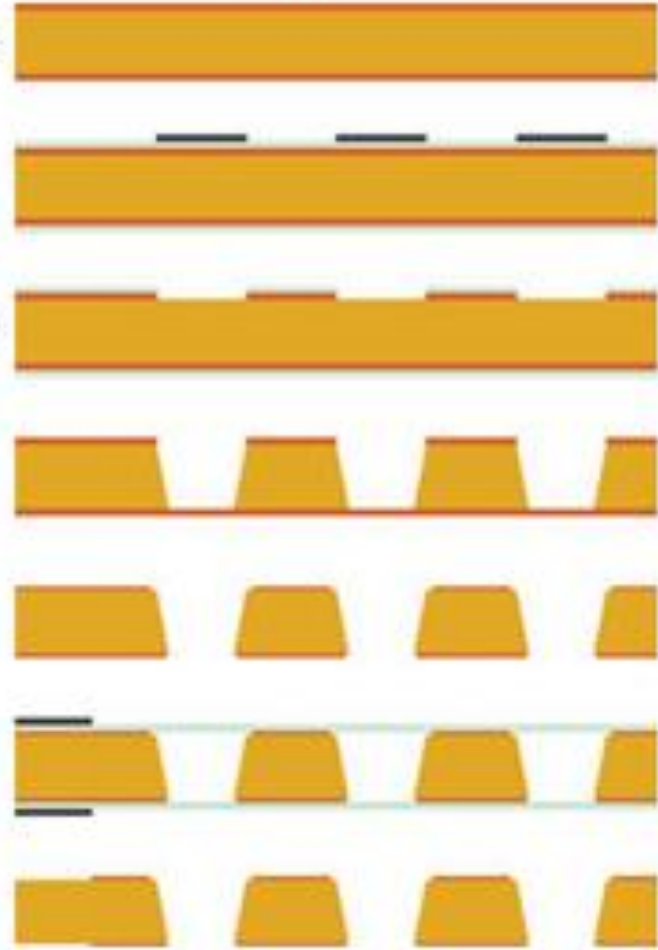
Kapton etching

Metal etching

Second masking, exposure

Development, etching, final cleaning

Single mask photolithography



GEM License and Training

CIAE is the first chinese institution which signed officially the LICENSE AGREEMENT FOR MANUFACTURING AND COMMERCIALISATION OF GEM FOILS AND GEM-BASED PRODUCTS with CERN.

I took a training for GEM foil at CERN.



北京市275信箱

Photolithography Room Construction At CIAE



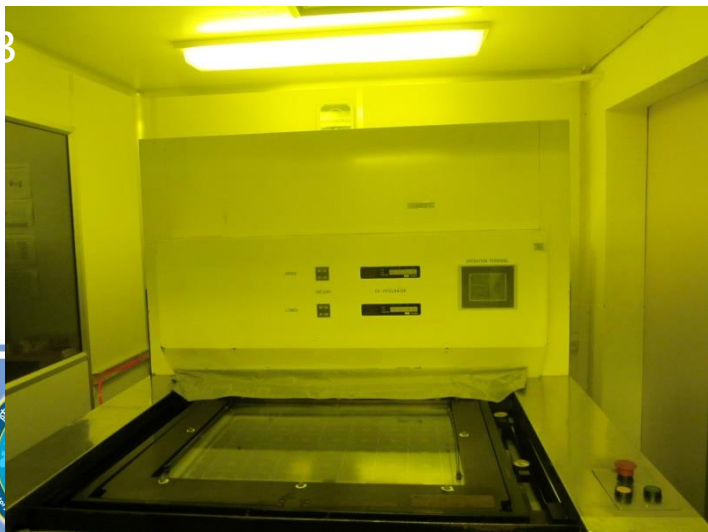
The Equipments for Lamination and Exposure of Dry Film Photoresist



Lamination and exposure of dry film photoresist are the most important and difficult steps for GEM foil production.

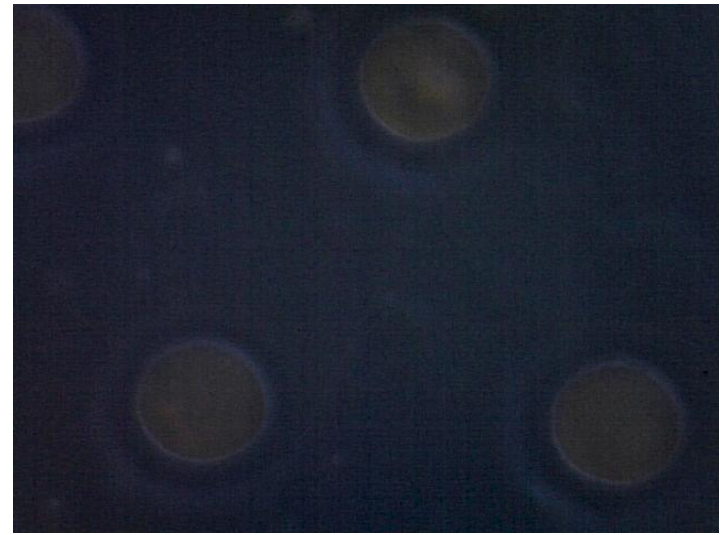
We have established a yellow light zone, Hot Roll Lamination (HRL) machine and Exposure system.

We invited a senior engineer from a famous electronic factory to CIAE and taught the PCB technology.



Exposure of Dry Film Photoresist

We use negative photoresist for GEM image transfer, unexposed areas are relatively unchanged and easily washed out during the development.



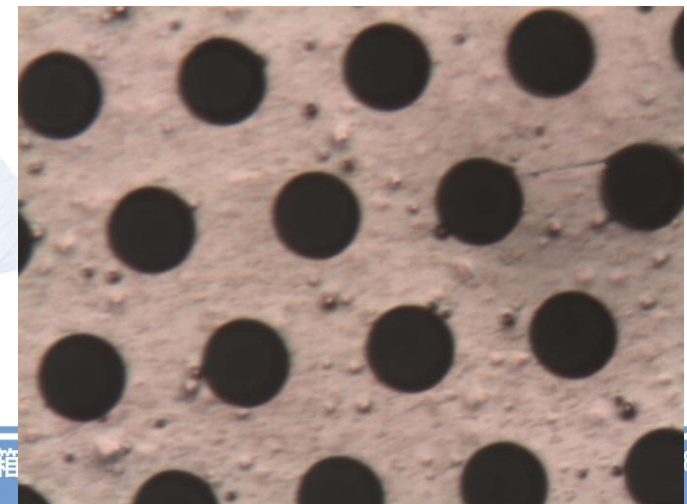
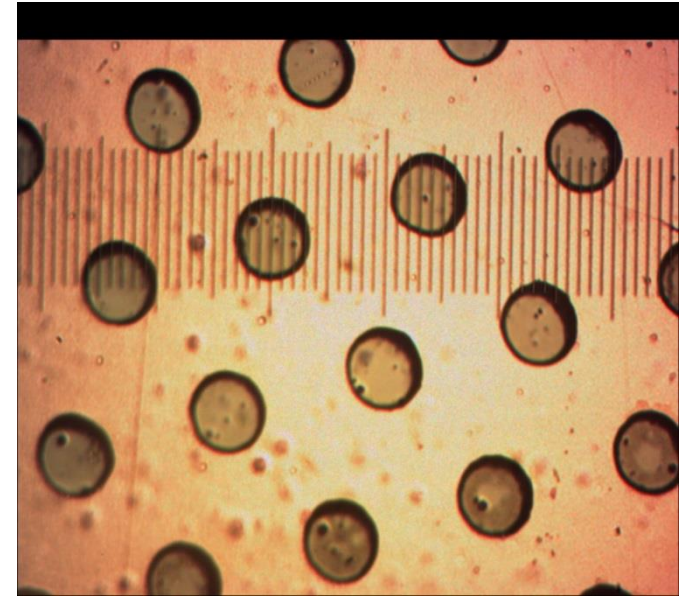
To obtain an identical copy of the photo-mask to the photoresist, vertical sidewalls in the resist are important.

We can observe the image transfer with good accuracy.



Copper Etching and Kapton Etching

- The size of the hole is 70um as expected

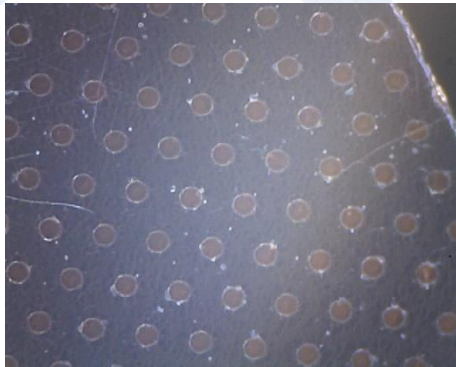


Etching Room Construction



Comparison of Foils Made in Different Conditions

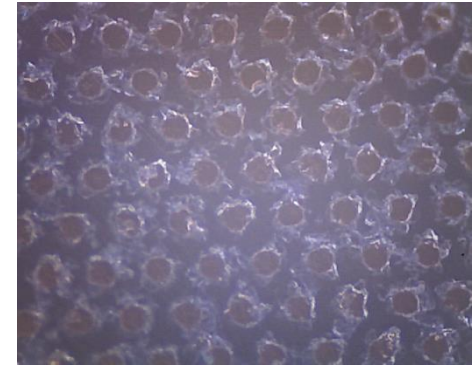
Insufficient development



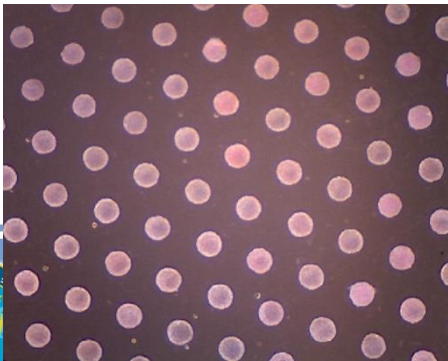
Good development



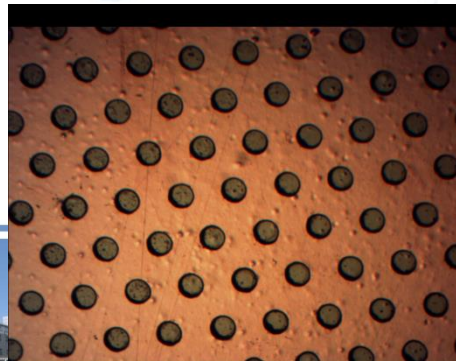
Excessive development



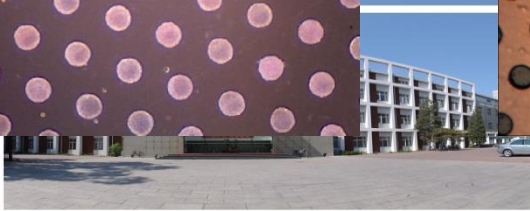
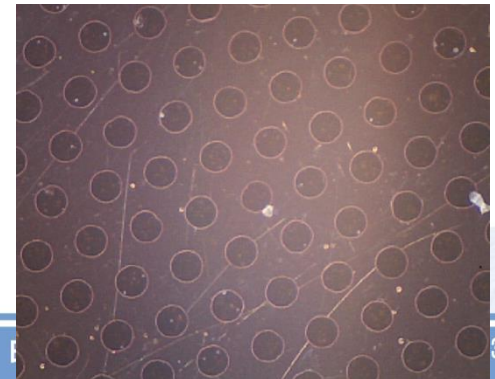
Insufficient copper etching



Good copper etching

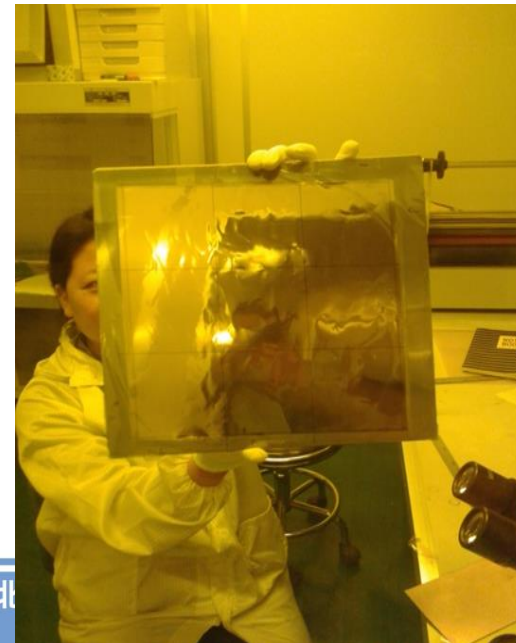


Excessive copper etching

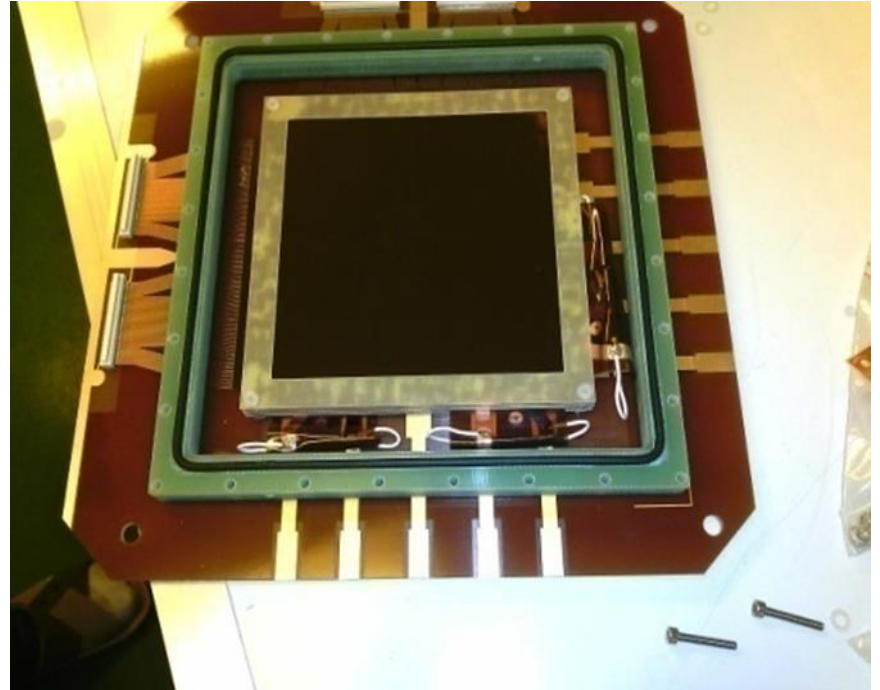
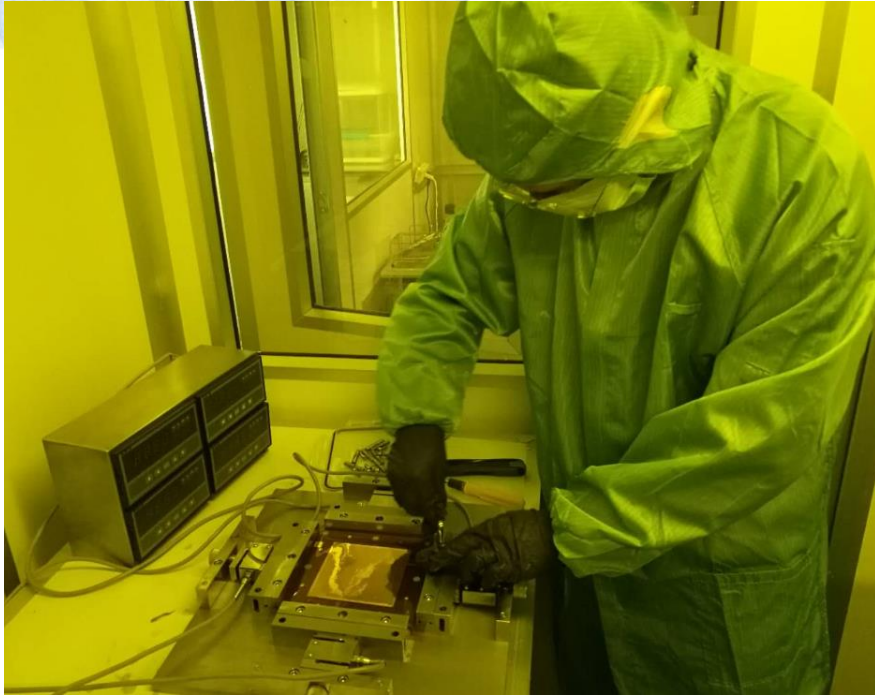


50cm*50cm GEM Foil

- The 50cm*50cm GEM foils were made successfully.
- Single-mask method was used.
- We did more than 200 samples before reaching this result.
- Sometimes the alignments of top and bottom masks were not perfect especially for large GEM foil. We have upgraded our alignment system.



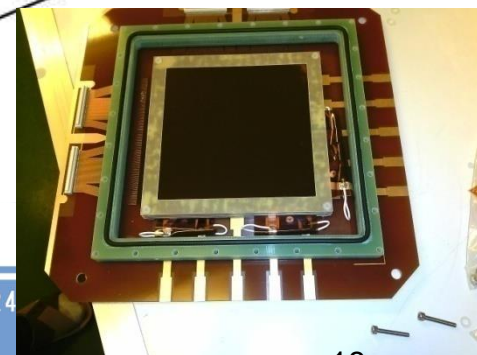
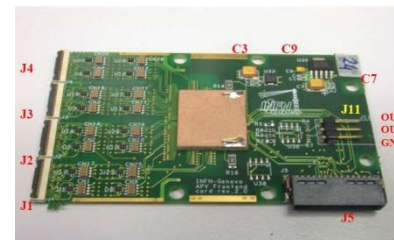
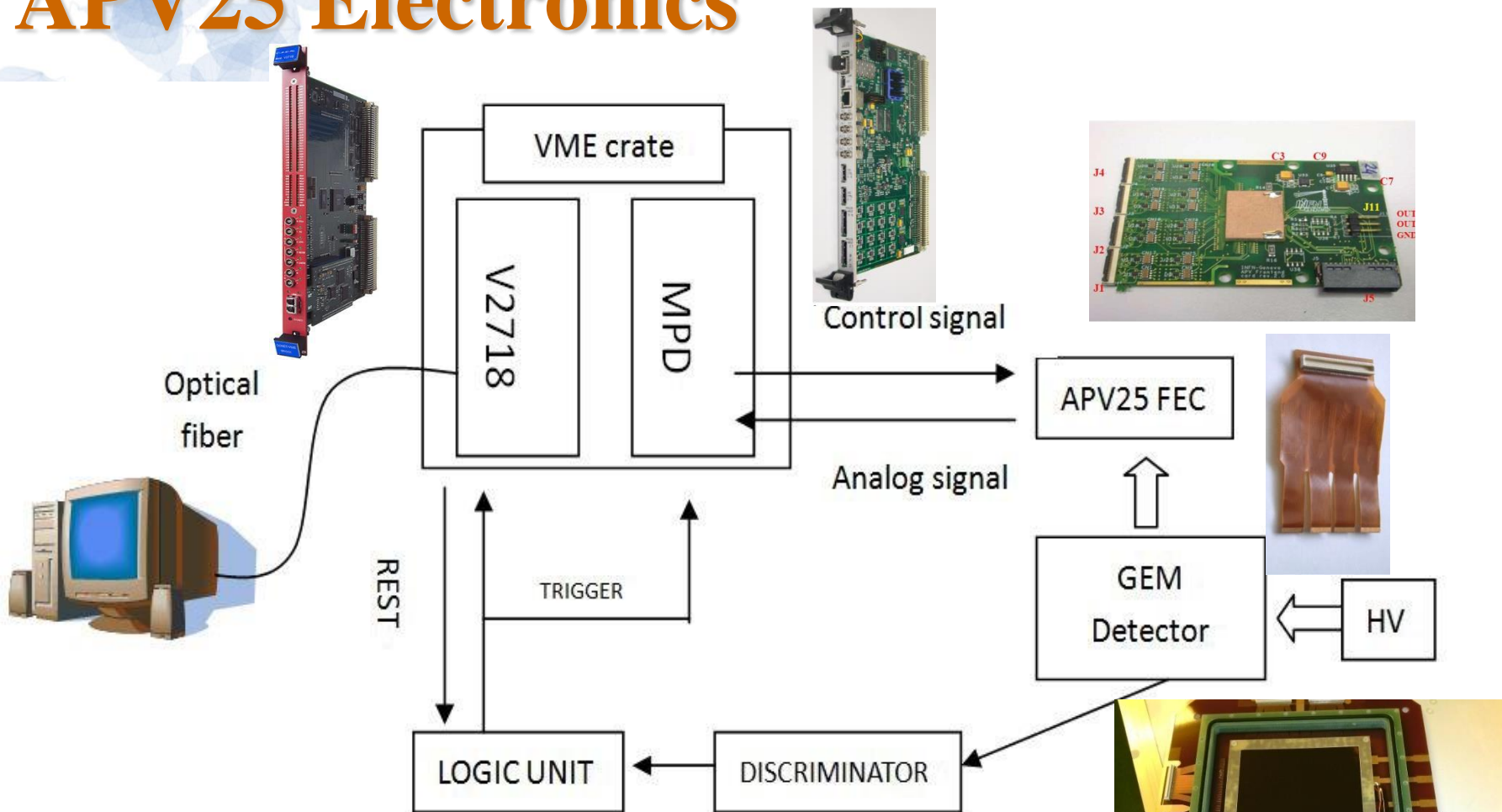
GEM Detector Assembly at CIAE



active area 10*10cm



GEM Test system with APV25 Electronics



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Spatial resolution

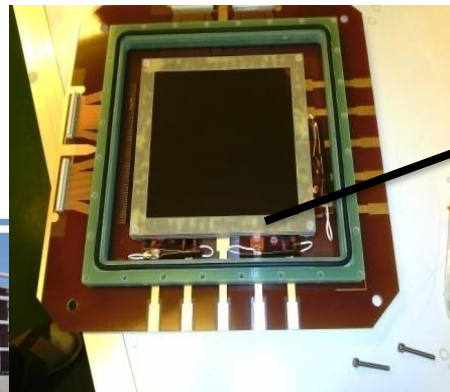
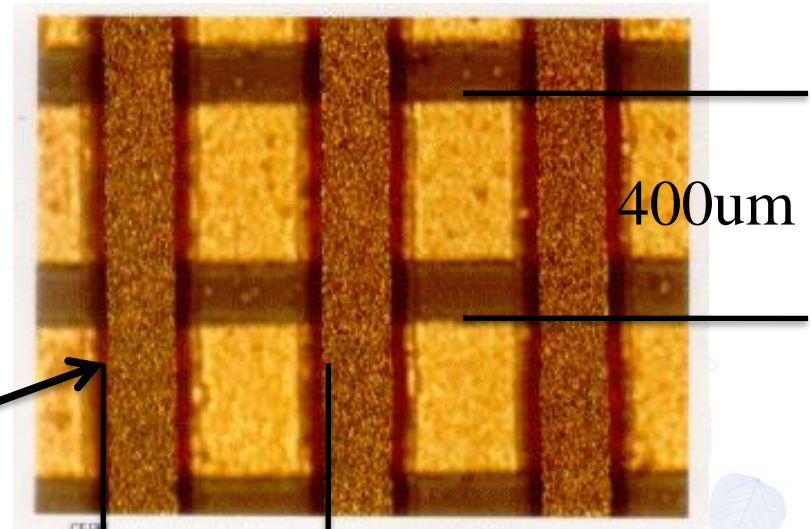
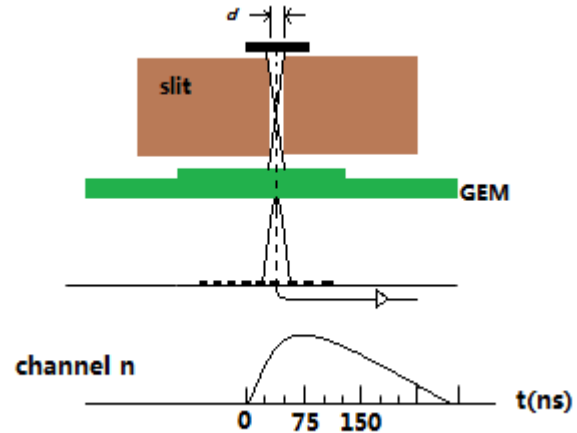
$$\sigma_{\text{tot}}^2 = \sigma_{\text{GEM}}^2 + c_1 \sigma_{\text{geometry}}^2$$

When: $\sigma_{\text{geometry}} \ll \sigma_{\text{GEM}}$

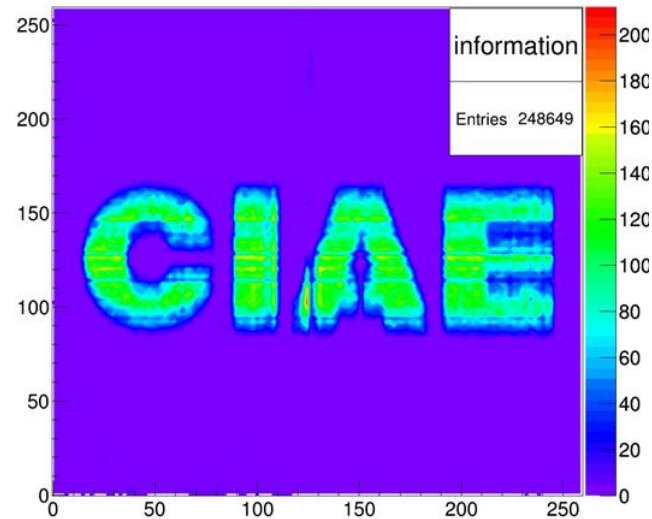
$$\sigma_{\text{tot}}^2 \cong \sigma_{\text{GEM}}^2$$

Spatial resolution $\approx 76\mu\text{m}$

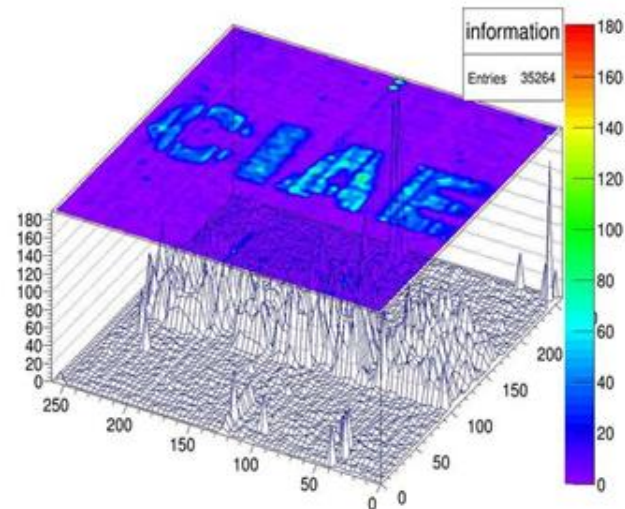
- **Slit(μm): 20;**
- **Ar: CO₂=70% : 30%;**
- **HV: 3600V;**
- **The distance between strips: 400 μm .**



X-ray imaging @ CIAE

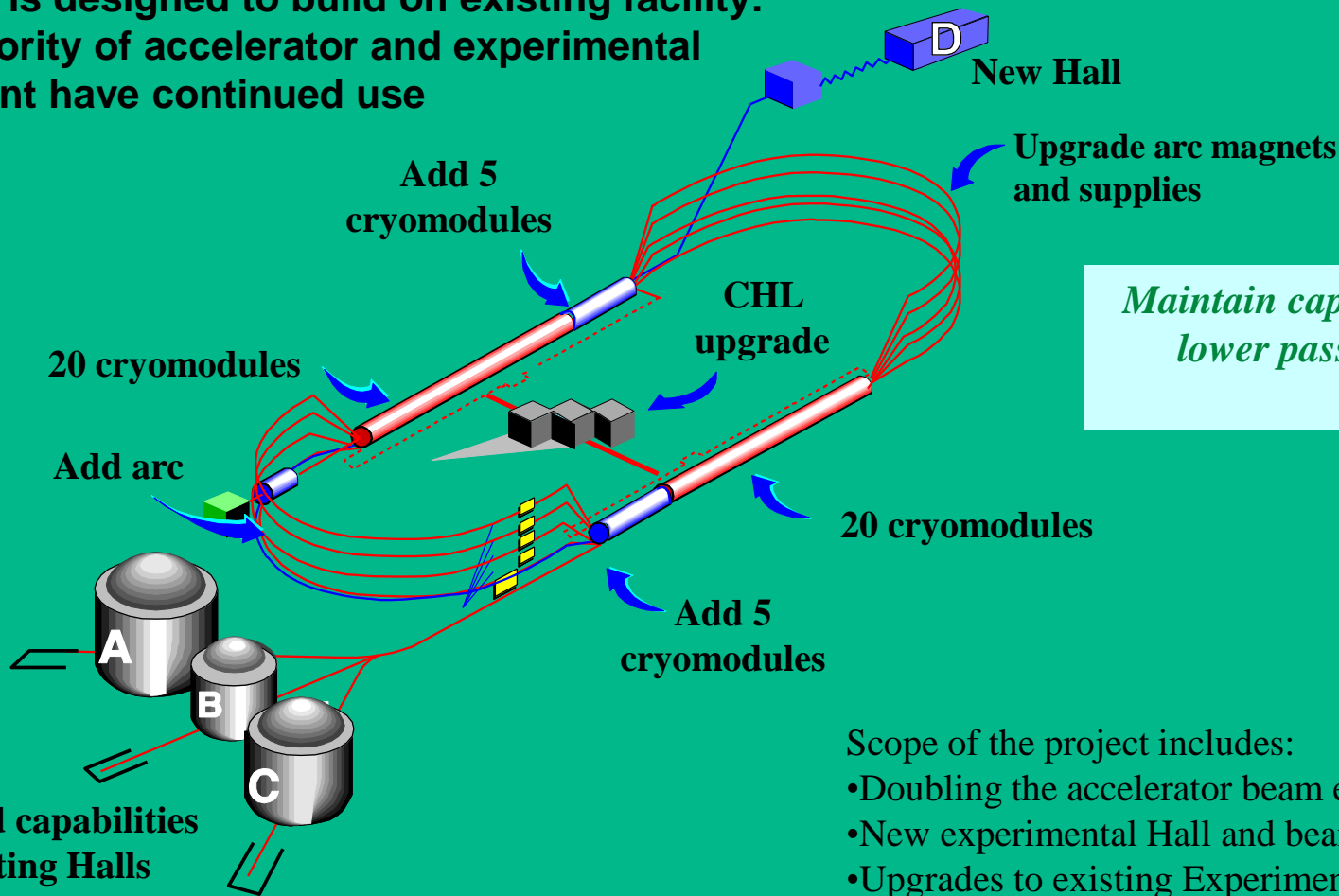


- X ray Energy: 8.9keV;
- about 1k sample rate
- 256 channels for each dimension(512 channel in total);
- 4 APV FECs were used (2 for each dimension)



JLab 12 GeV Upgrade

Upgrade is designed to build on existing facility:
vast majority of accelerator and experimental
equipment have continued use



*Maintain capability to deliver
lower pass beam energies:
2.2, 4.4, 6.6....*

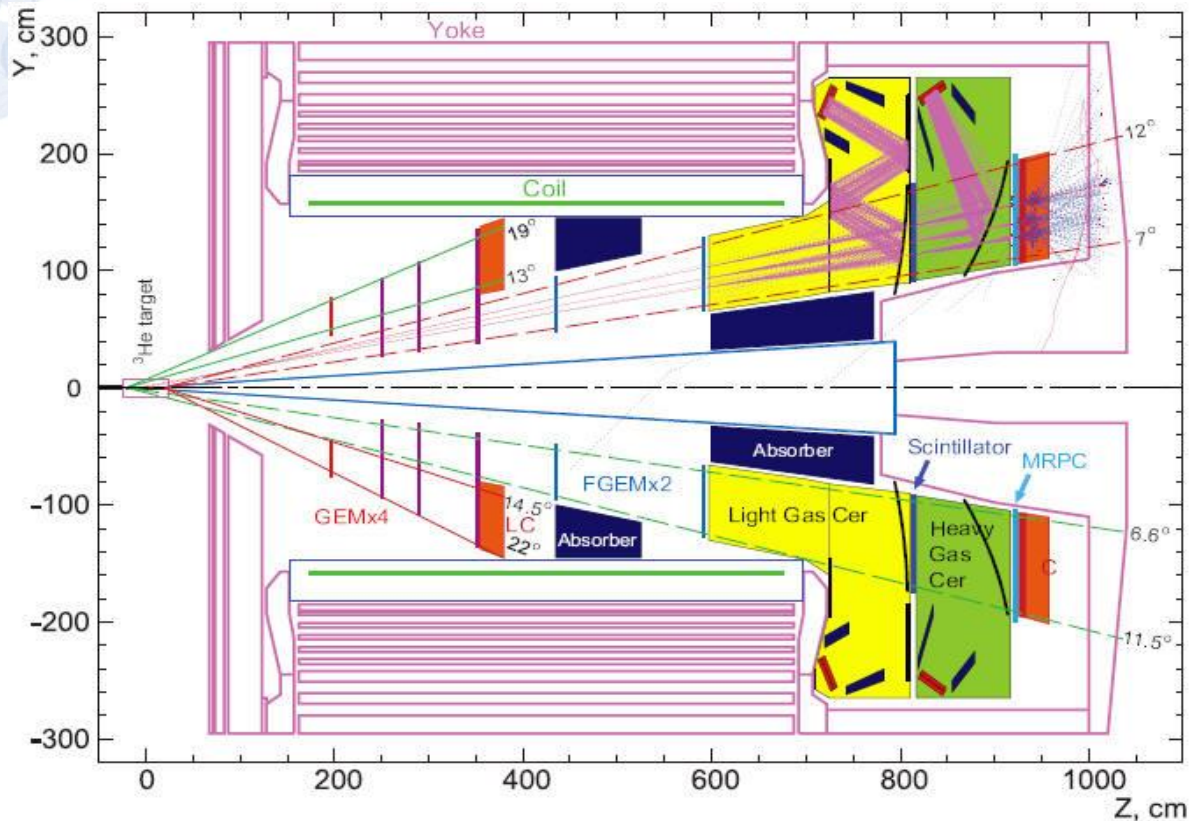
Scope of the project includes:

- Doubling the accelerator beam energy
- New experimental Hall and beamline
- Upgrades to existing Experimental Halls

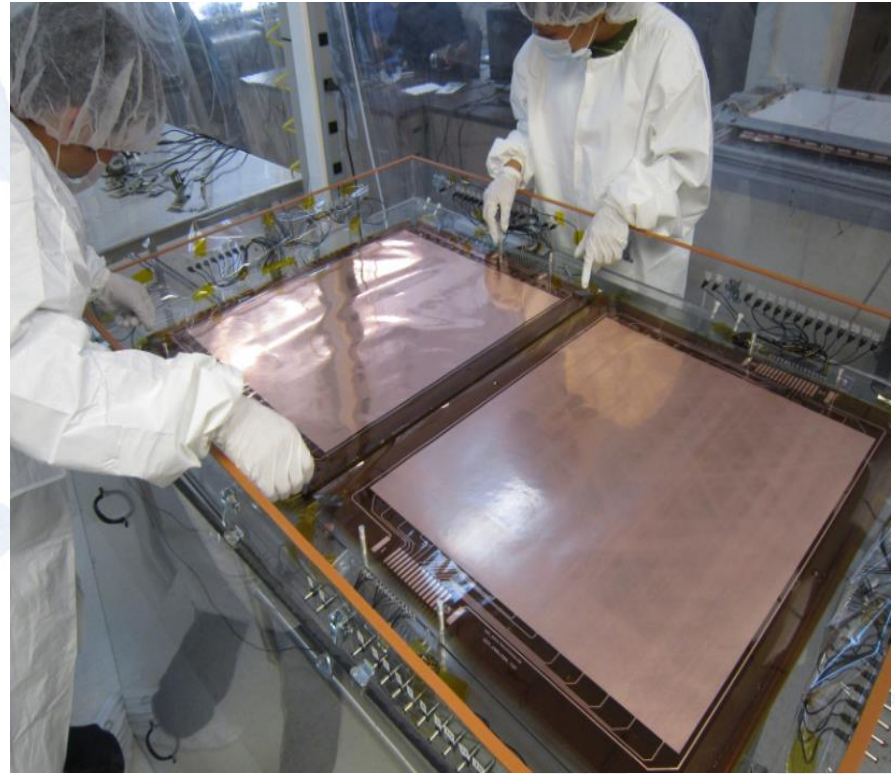
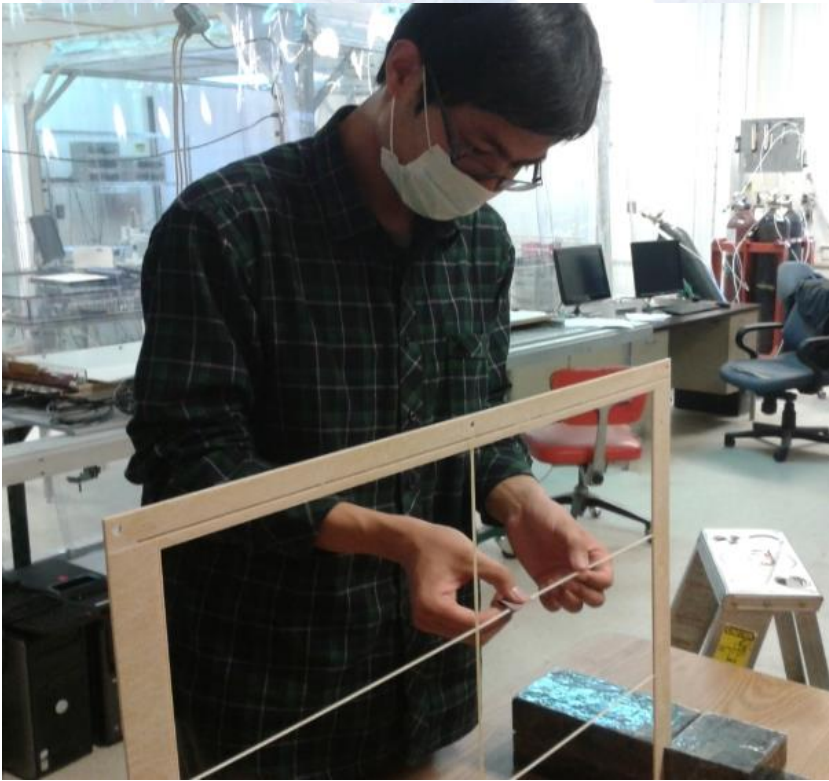
Enhanced capabilities
in existing Halls



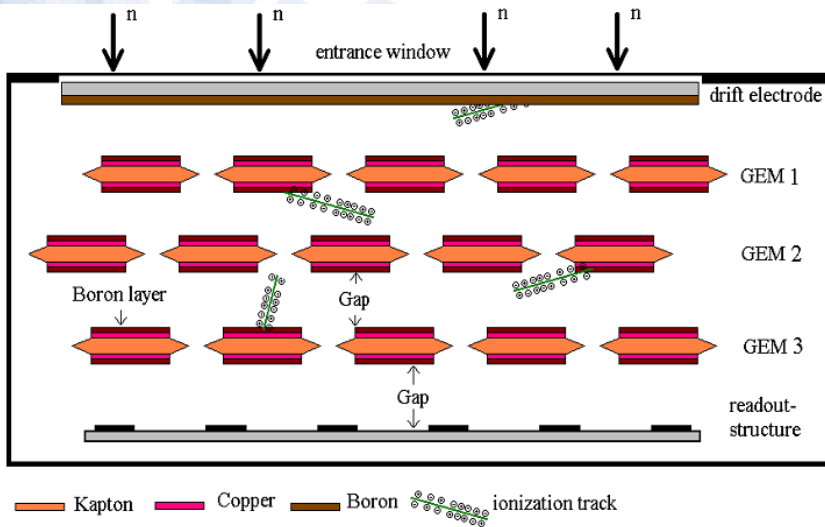
GEM: SoLID Spectrometer at JLab



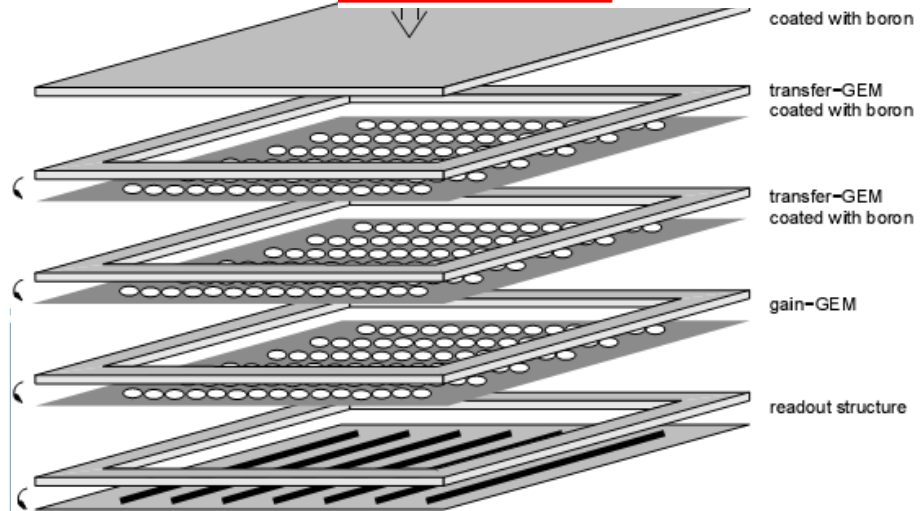
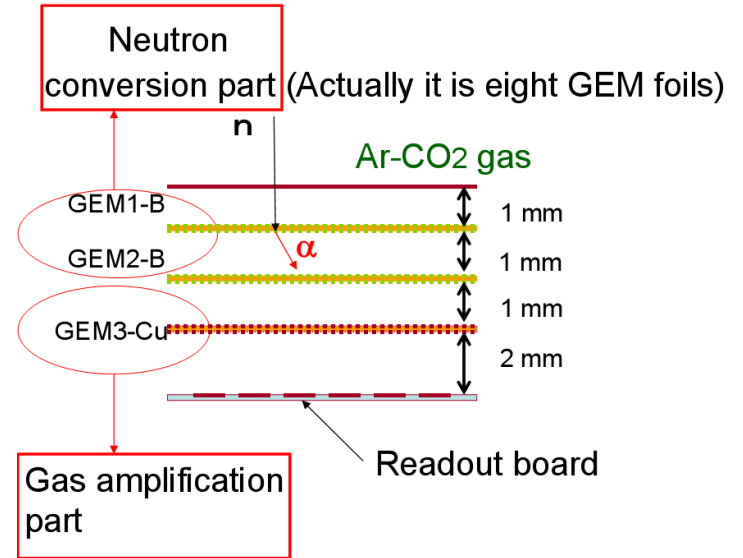
Students working at JLAB and UVA



GEM: Neutron Detection



KEK



R&D of MicroMegs at CIAE

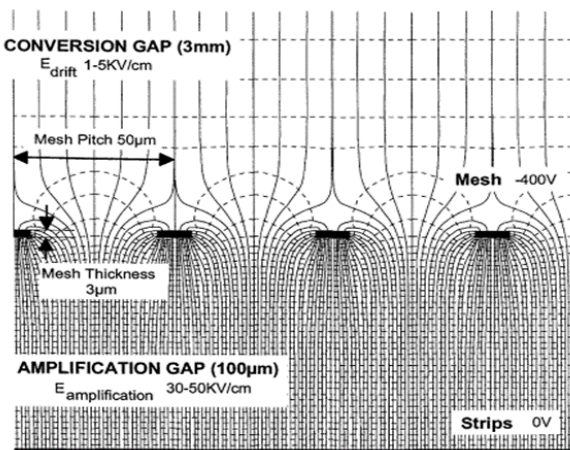
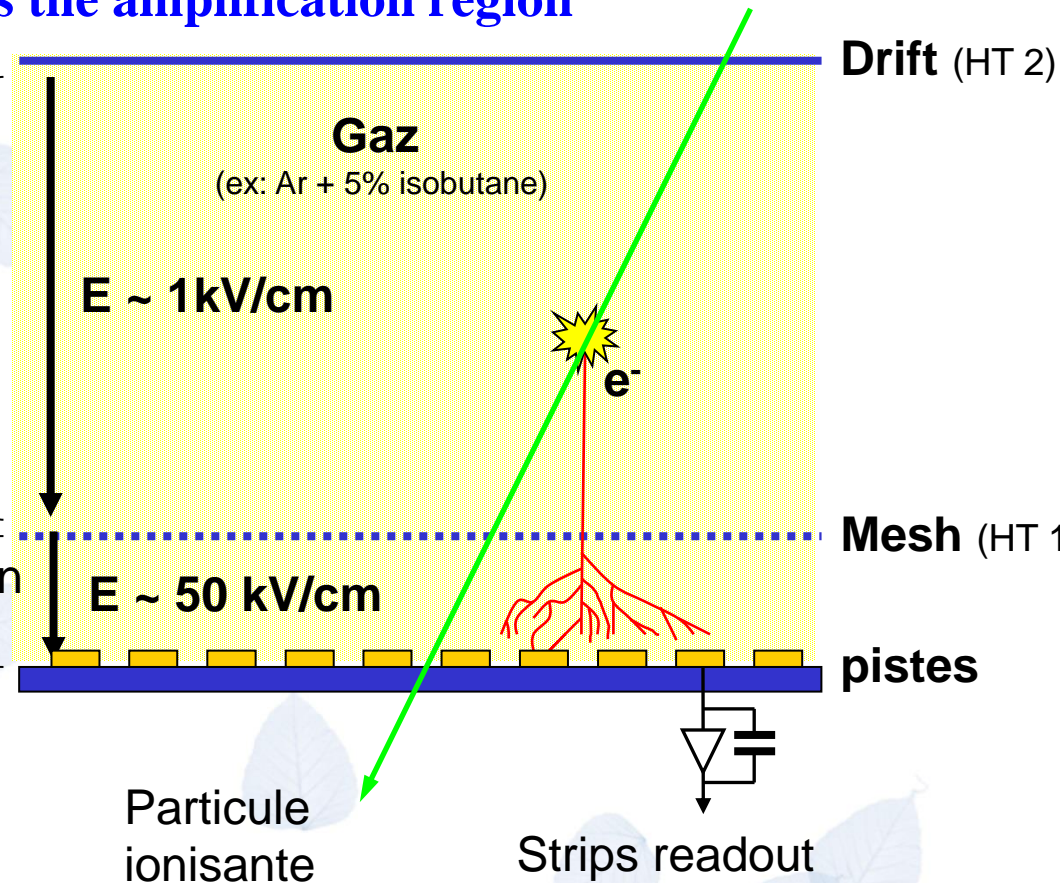


Structure of MicroMegas

- The core of the detector is the amplification region

Conversion region:
1 mm à 1 m

Amplification region
~ 100 μ m



Micromegas Classifications

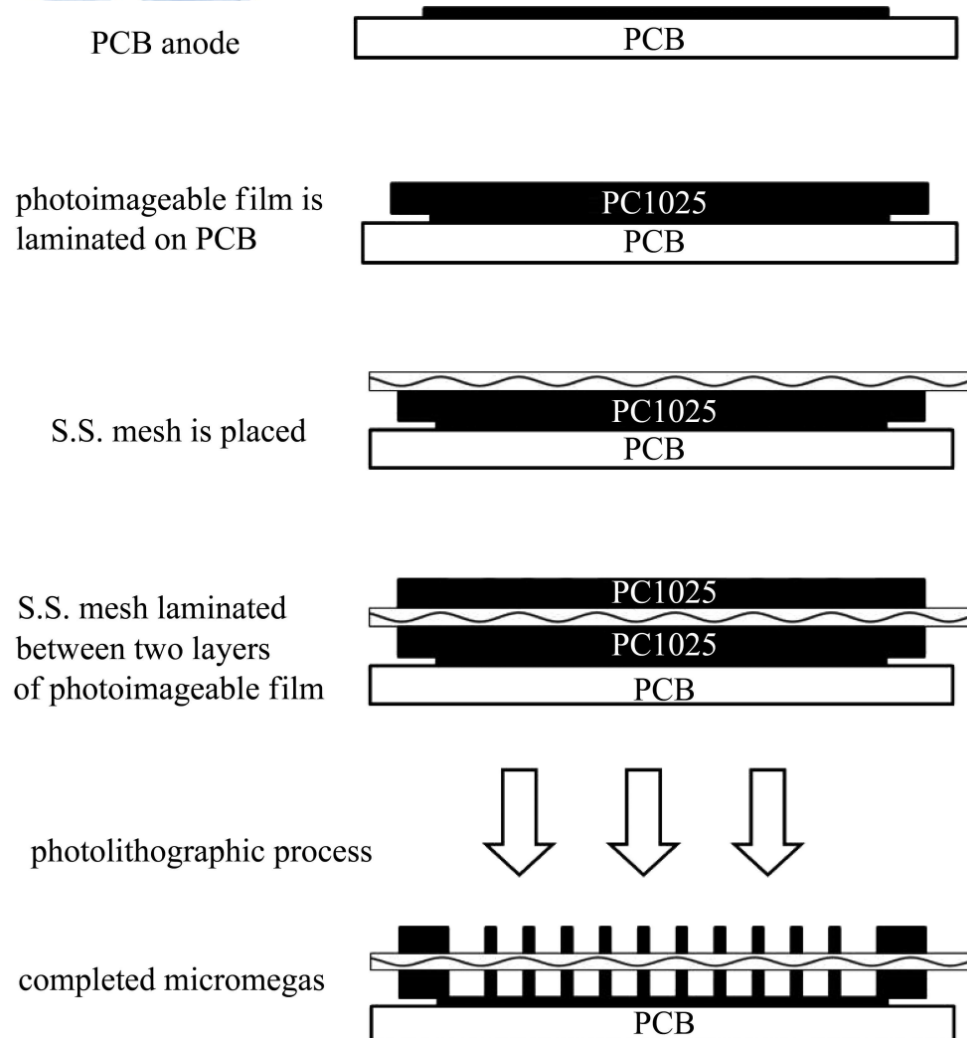
- **Classic Micromegas**
 - Mesh on a frame
- **Bulk Micromegas**
 - photolithography process is used to attach the mesh on the PCB.
- **Microbulk Micromegas**
 - Mesh and PCB made on a unique kapton foil, the mesh layer is thinner.



22/04/2024



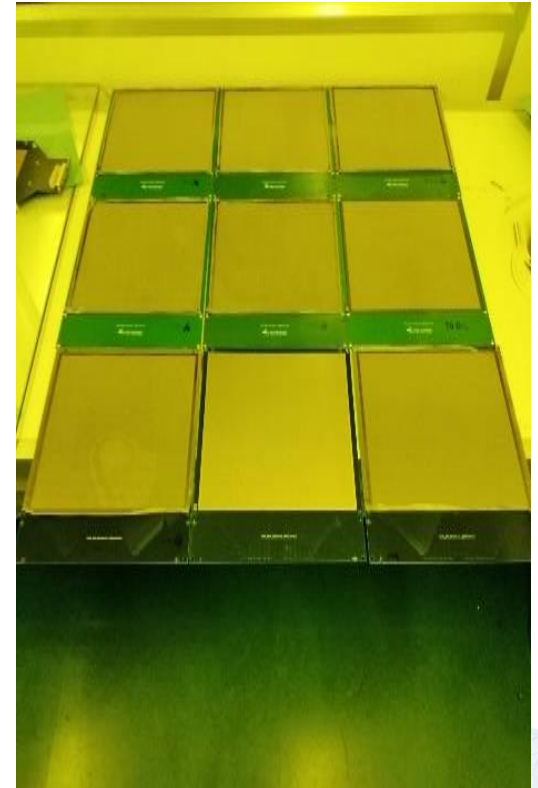
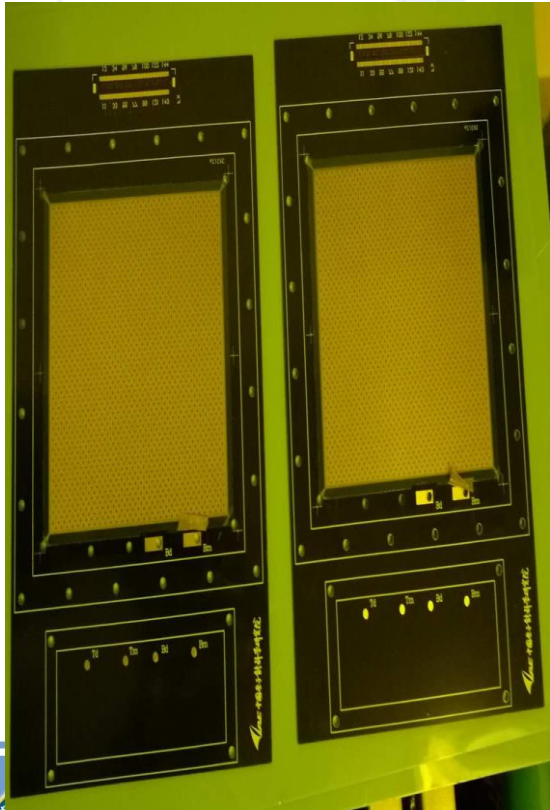
Structure of Bulk MicroMegas



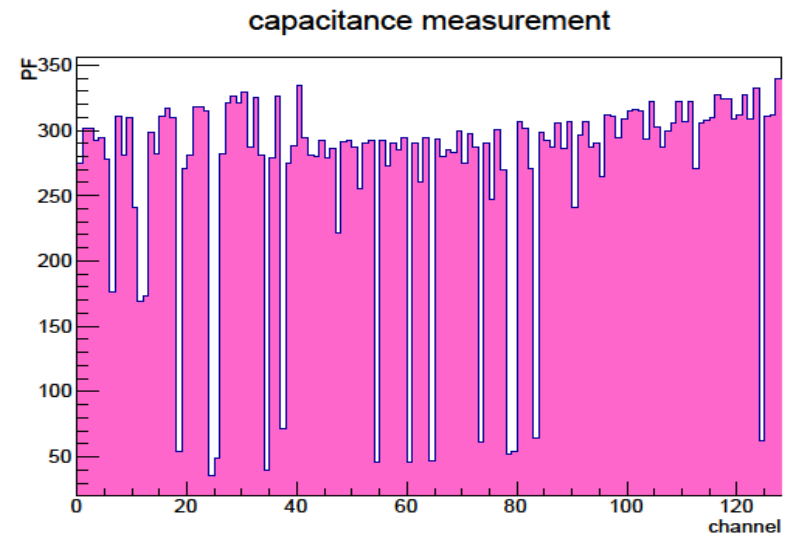
Reference: Study of bulk micromegas detector
Chinese Physics C Vol. 34, No. 10, Oct., 2010



Manufacture of Bulk MicroMegas at CIAE



Capacitance and Resistance Automatic Testing System Invented by CIAE



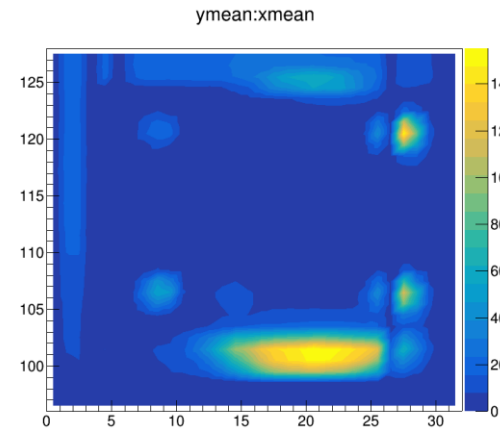
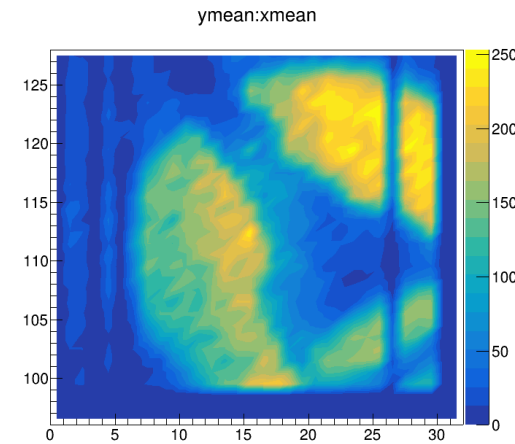
不同通道电容值

分布图

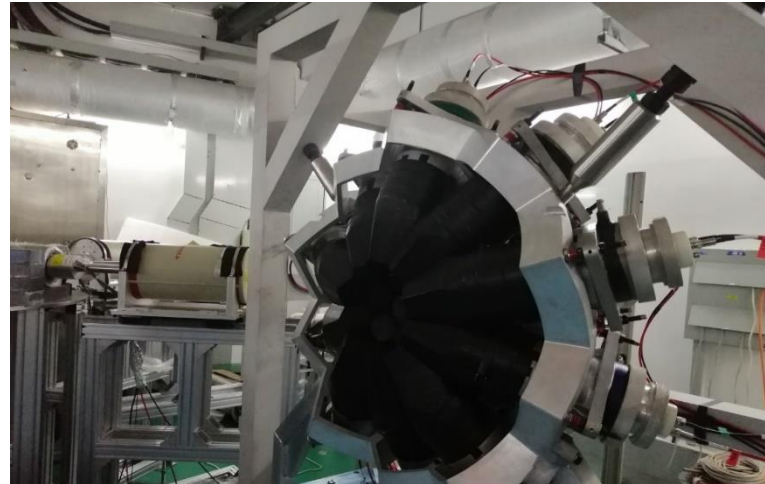
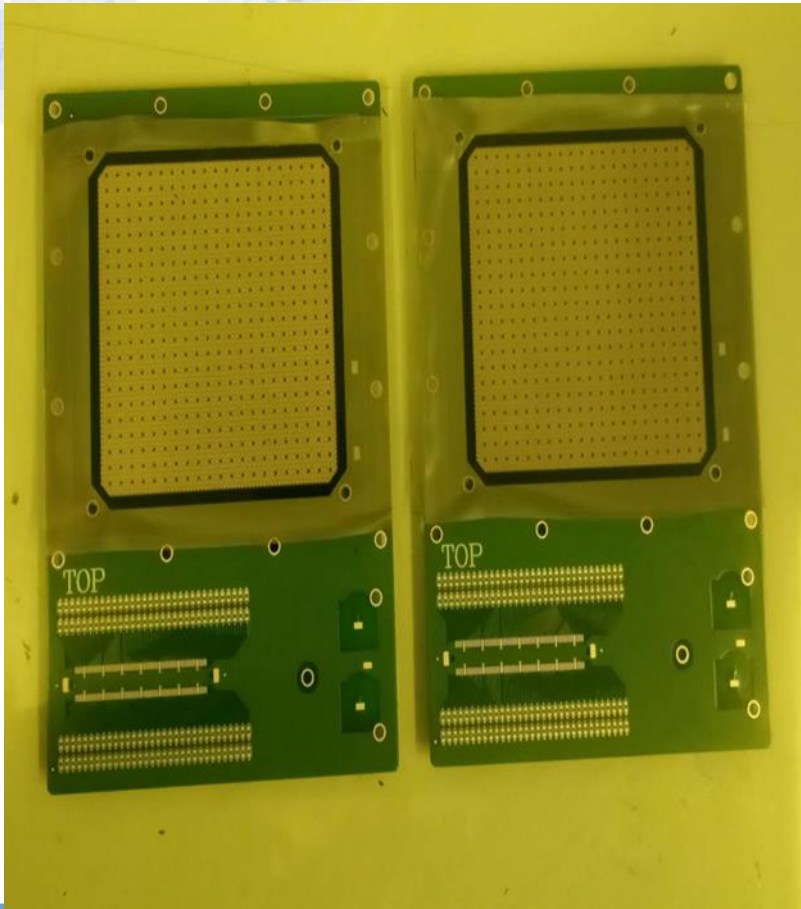


Bulk Micromegas X-Ray Imaging

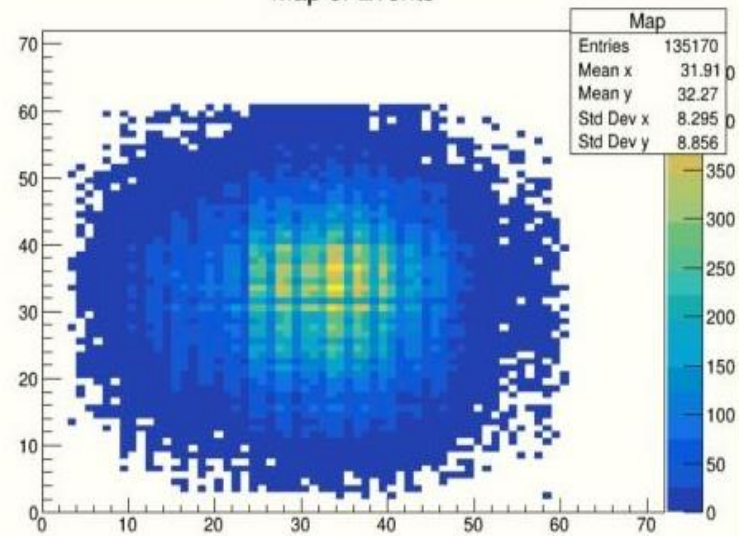
- Bulk Micromegas
- Argon + 30%CO₂
- Mesh: -550V(max -620V)
- Drift: -2500V
- 50kV X-Ray tube



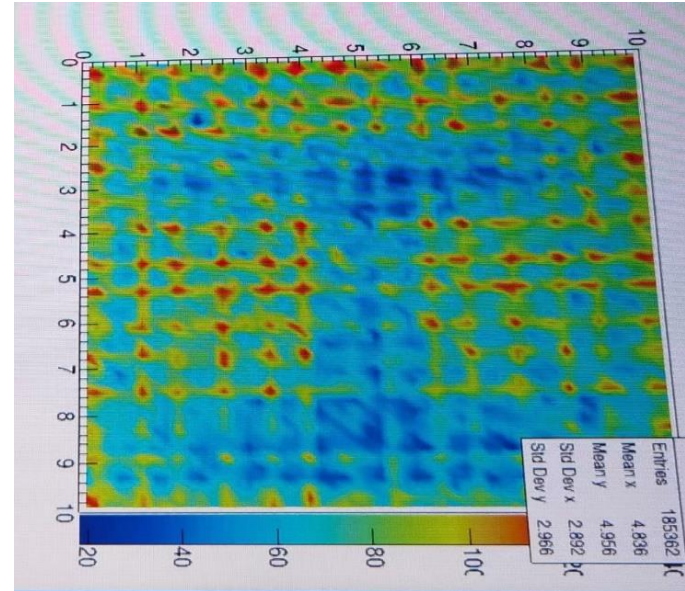
Neutron imaging at China Spallation Neutron Source



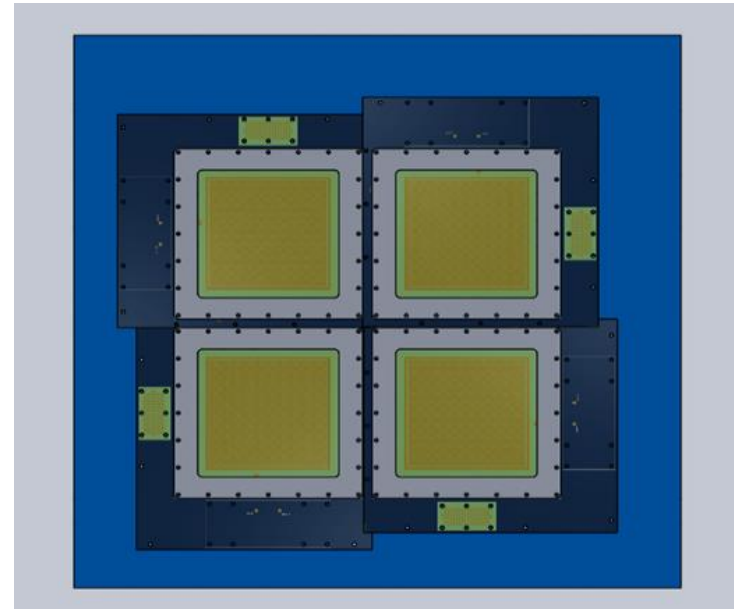
Map of Events



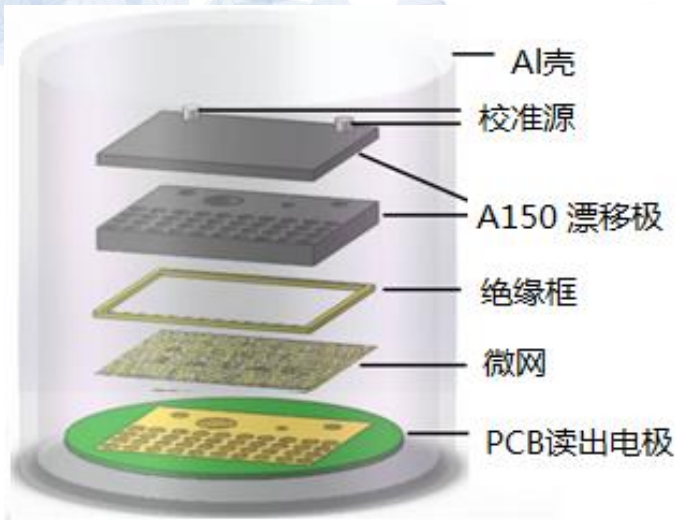
Neutron Imaging at CIAE



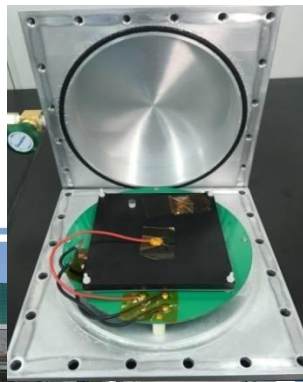
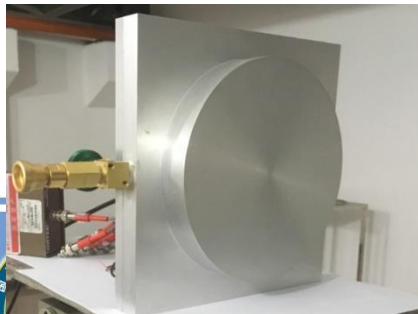
Neutron Imaging at CIAE 100MeV Cyclotron



Bulk MicroMegas: TEPC at CIAE



**TEPC is widely used in
microdosimetry.
Compare with MWPC:
Easy Assembly,
More Sensitive**

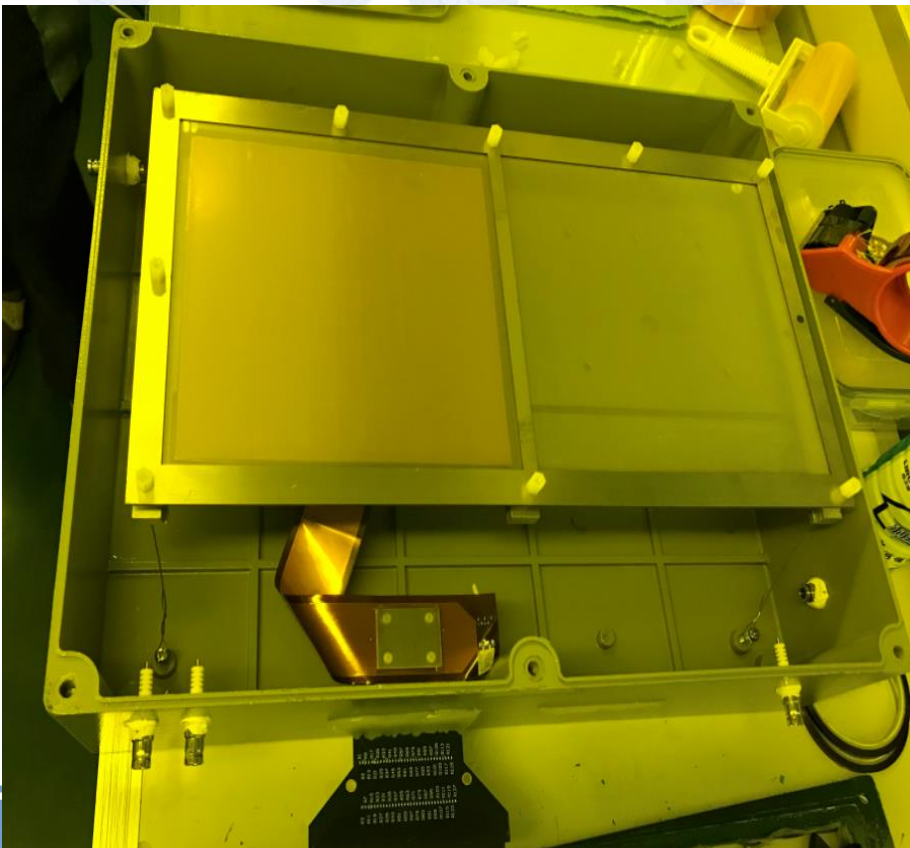


**Compare with GEM:
More stable**

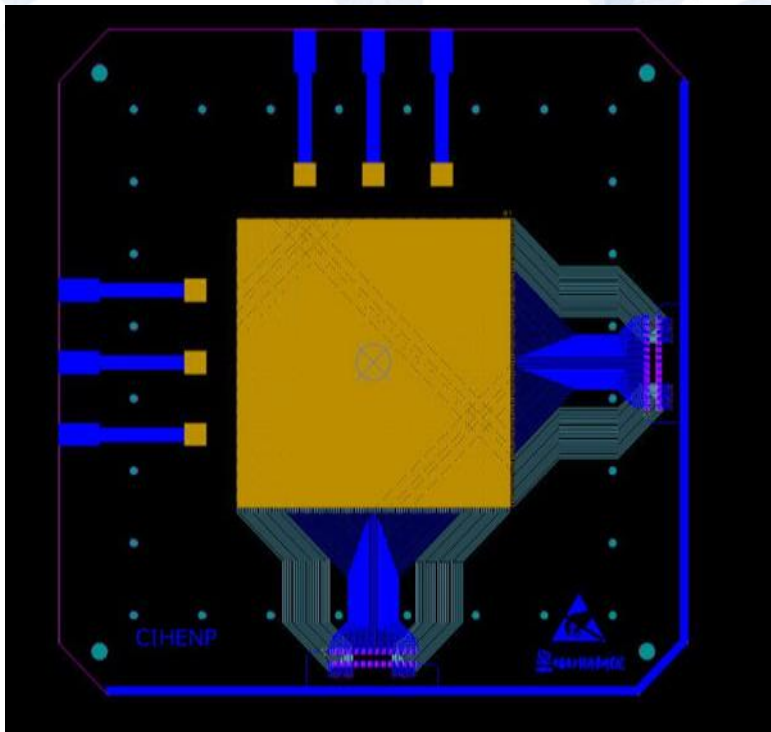
Tissue Equivalent

Proportional Counter

PandaX-III MM Test Platform at CIAE



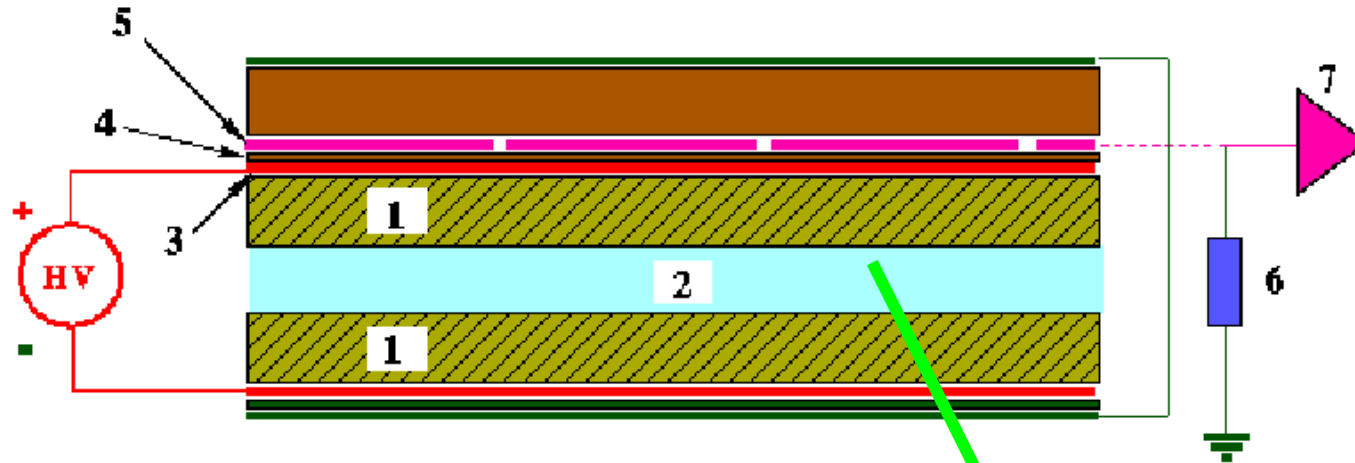
Bulk MicroMegas for the R&D of CEPC TPC



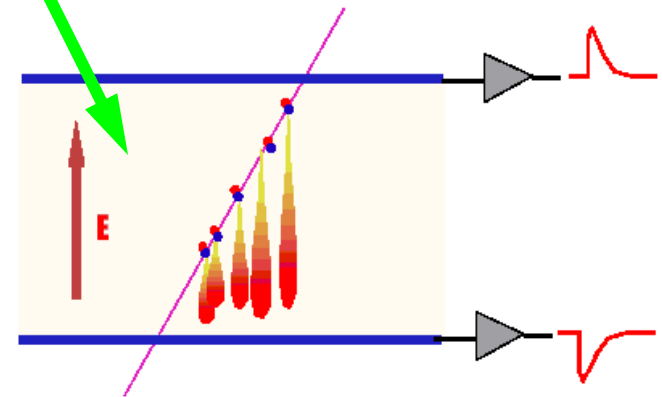
R&D of PRC at CIAE



Structure of RPC



- Bakelite resistivity 10^{10} - $10^{12} \Omega\text{cm}$
- Gas Gap: 2 mm
Gas pressure : $\sim 1 \text{ Atm}$
Gas mixture: F134a, Isobutane, SF_6
- HV electrodes : $100 \mu\text{m}$ graphite
- Read-out strips



RPC Prototypes



The upstream of Prototype No.2 is separated into two parts and the readout strips are jointed with ground by matched resistances.

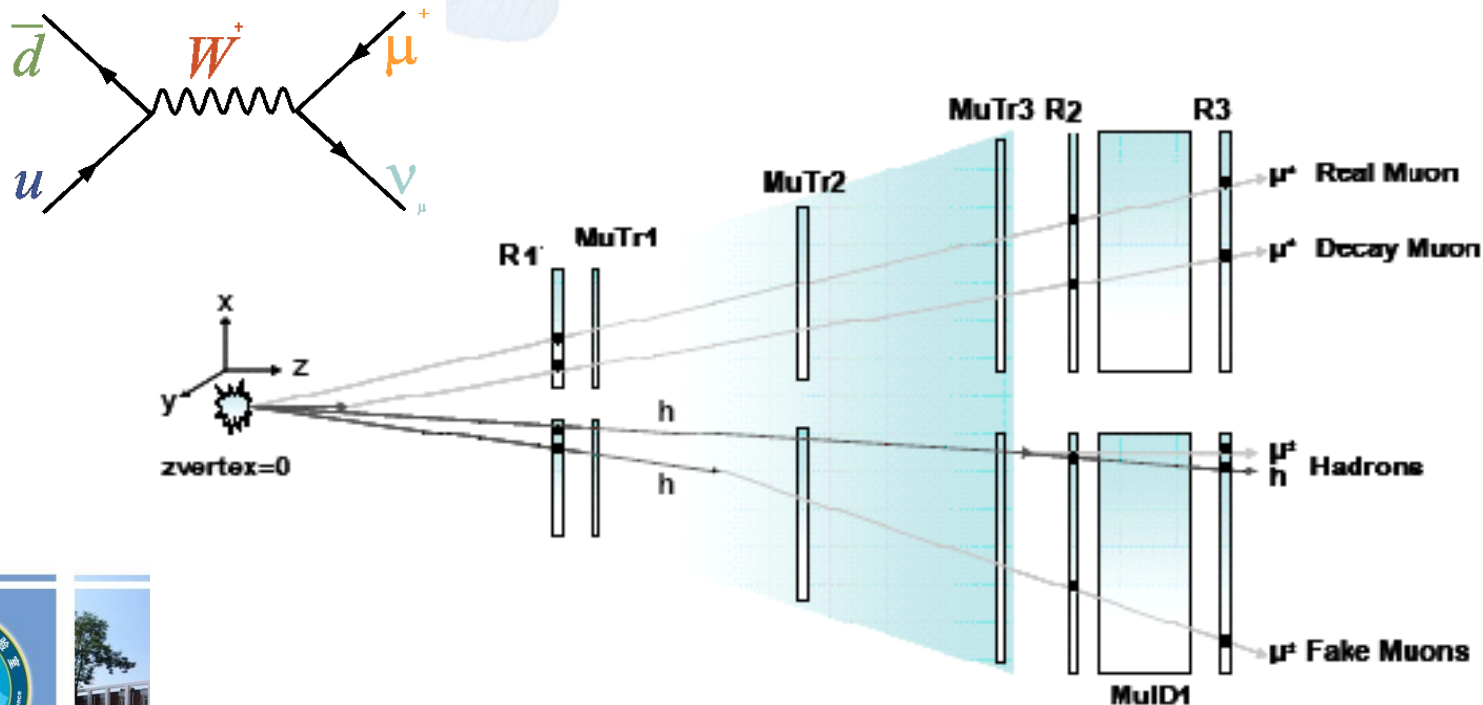


PHENIX @ BNL



Motivation of the PHENIX Forward Upgrade

Add RPC (Resistive Plate Chamber) as a fast muon trigger to study the quark-gluon structure of the proton by observing W-bosons from colliding polarized proton beams at RHIC.

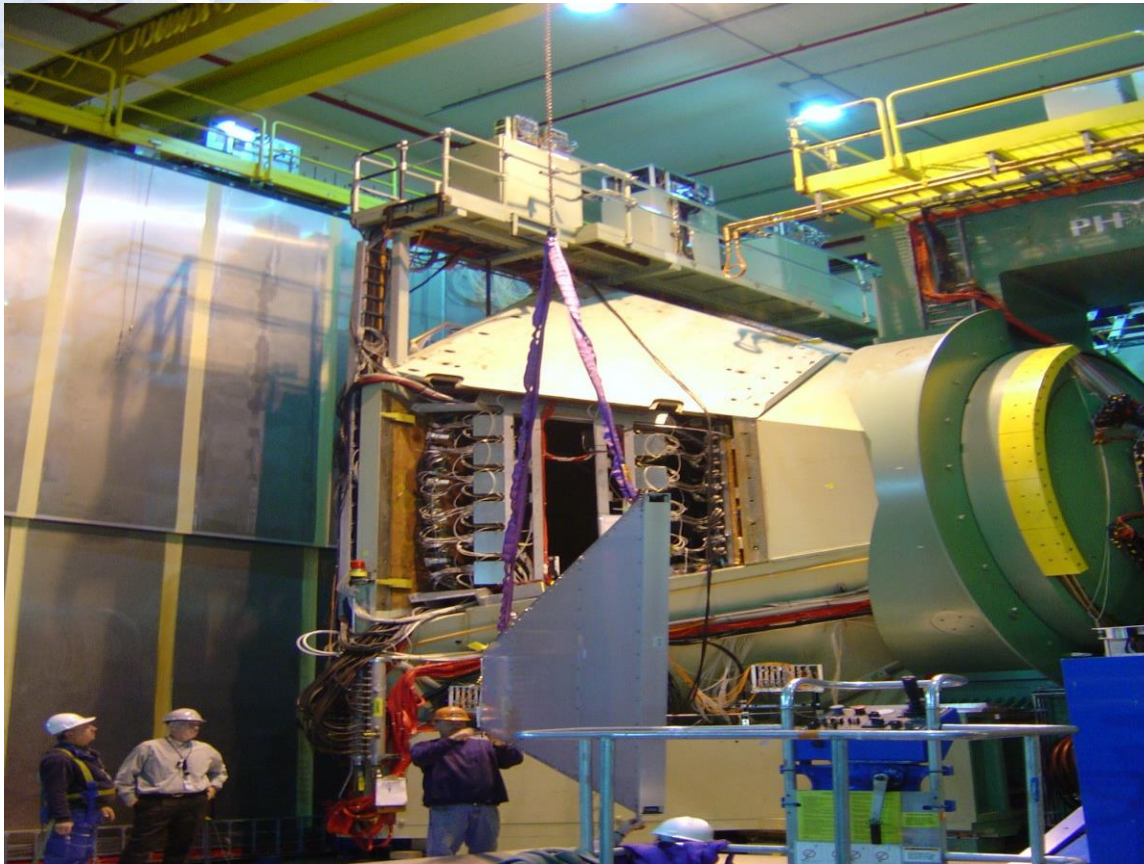


RPC installation at PHENIX

CIAE Carried out the design and production of the module parts of RPC detectors for PHENIX forward upgrade,



RPC installation at PHENIX



This work was awarded the Beijing Science and Technology Prize.

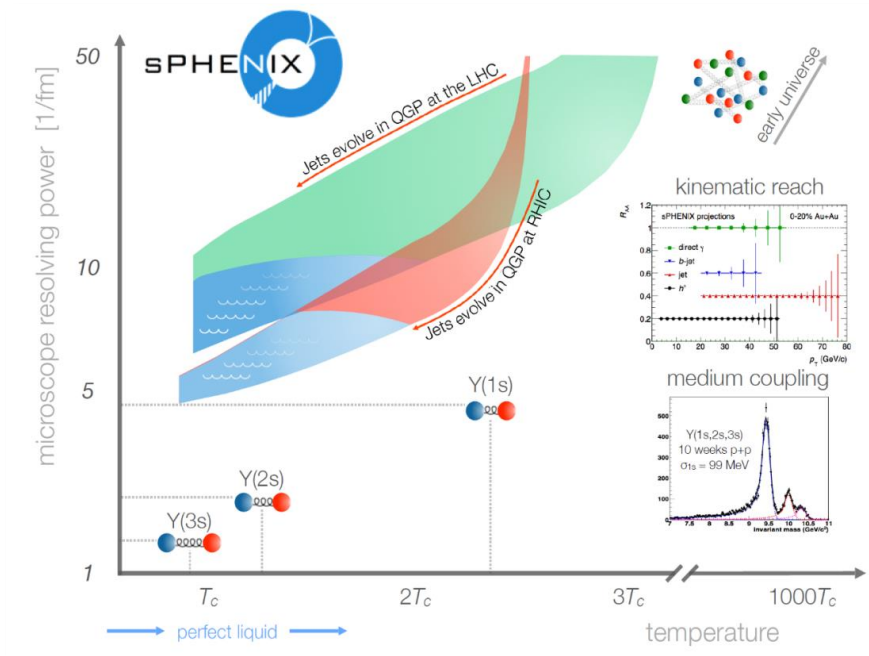


Developments of EMCal Detectors for sPHENIX

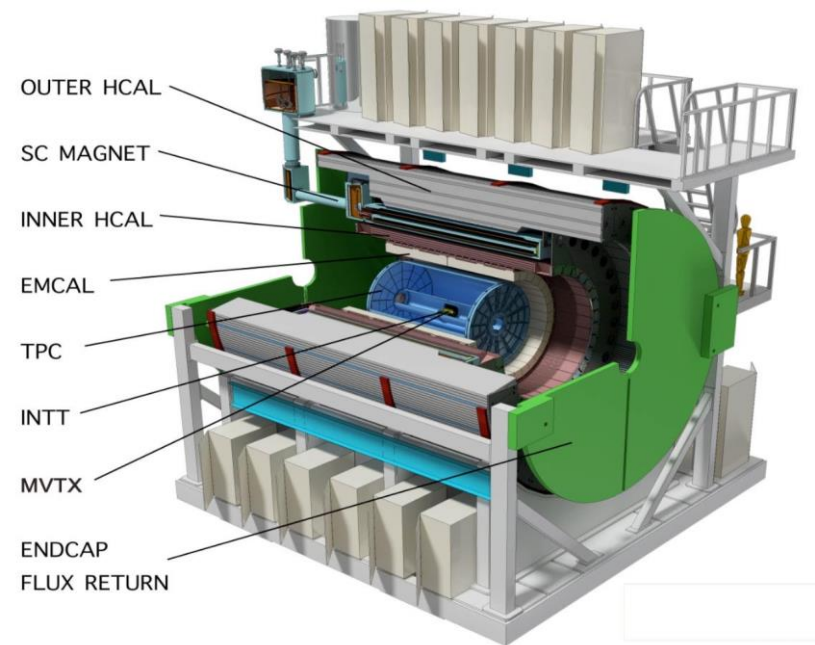


Objectives of sPHENIX

The scientific objective of the sPHENIX experiment is to gain an understanding of the evolution of the system and its coupling strength at RHIC from the initial high temperatures. It will address fundamental questions about the nature of the strongly coupled quark-gluon plasma (QGP). This will be accomplished by using hard-scattered partons that traverse the medium and the Upsilon states to investigate the medium at the different length scales.



Ref:arXiv:1207.6378v2 [nucl-ex] 27 Jul 2012

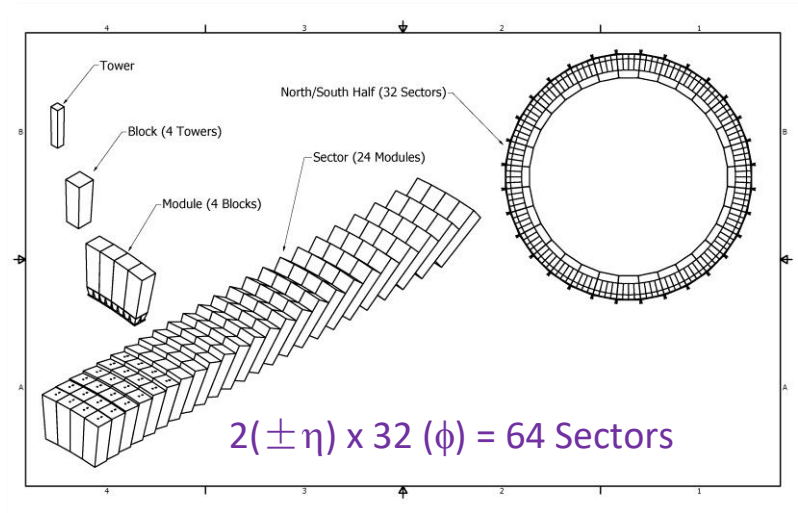
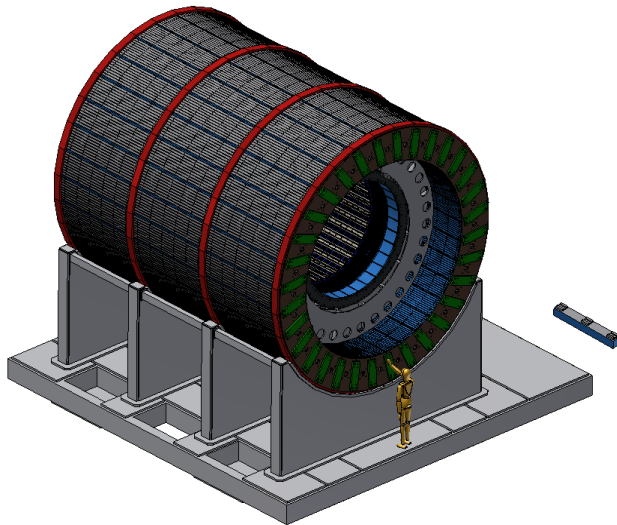


sPHENIX Detector

EMCal Design Performance

The EMCal (Electromagnetic Calorimeter) is an essential sub-detector for sPHENIX to measure the QGP near the critical temperature.

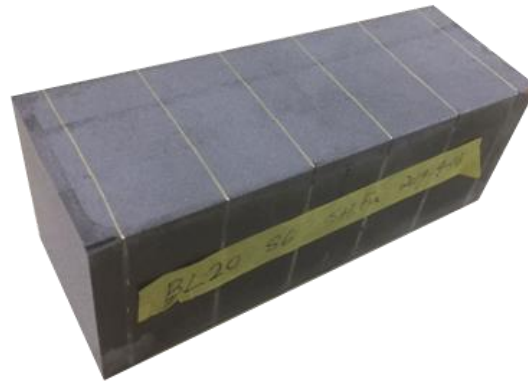
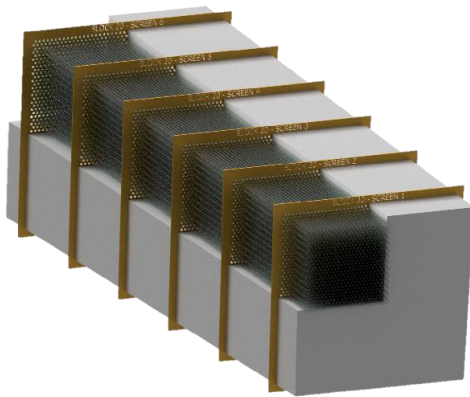
EMCal covering ± 1.1 in η and 2π in ϕ . $\Delta\phi \times \Delta\eta \sim 0.025 \times 0.025$



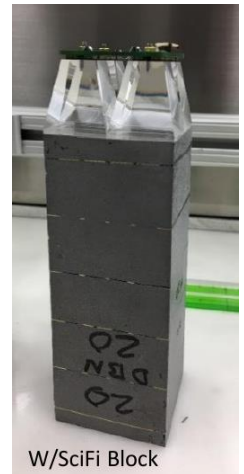
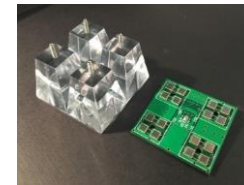
The EMCal performance is central to the direct photon and Upsilon measurements and it is also a key component, along with the HCal, of the jet reconstruction.

EMCal Block Design

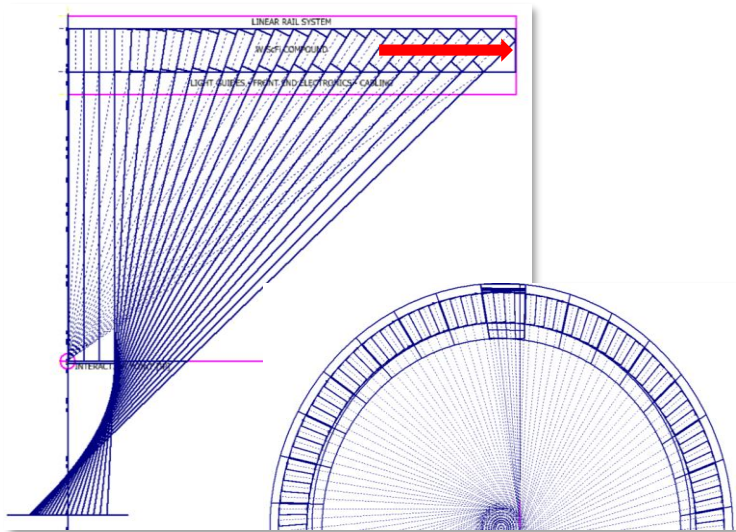
The EMCal block design consists of scintillating fibers embedded in the absorber material, which is a matrix of tungsten powder infused with epoxy (W/SciFi).



- High density (9-10 g/cm³), low radiation length (~7 mm), small Molière radius (~ 2 cm), compact structure and low cost.
- The readout system adopts light guide combined with SiPM.



The Contribution from China



- Total 6144 blocks for EMCAL
- 1248 blocks ($0.8 < |\eta| < 1.1$) will be made in China.

The pseudo-rapidity coverage of $0.8 < |\eta| < 1.1$ can greatly enhance the physics capability for jets and Upsilon measurements.

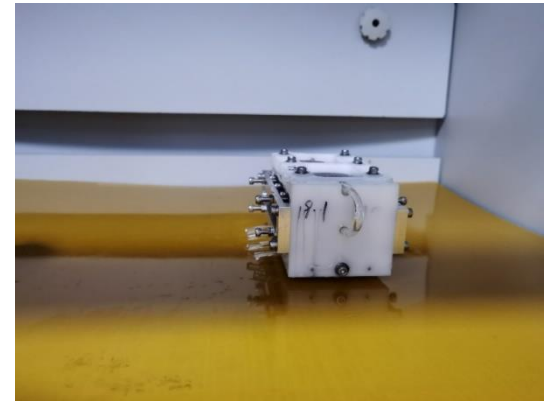
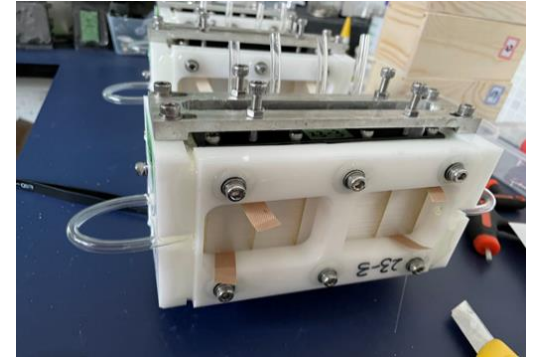
- Fudan, CIAE, and PKU are the main cooperative sites in EMCAL construction and make an important contribution to the sPHENIX experiment.

sPHENIX EMCal R&D Center at CIAE

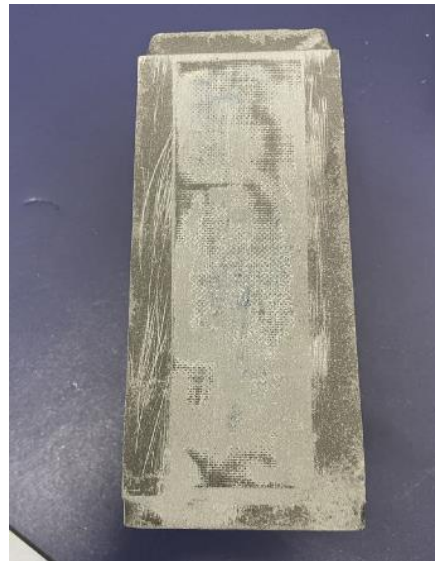
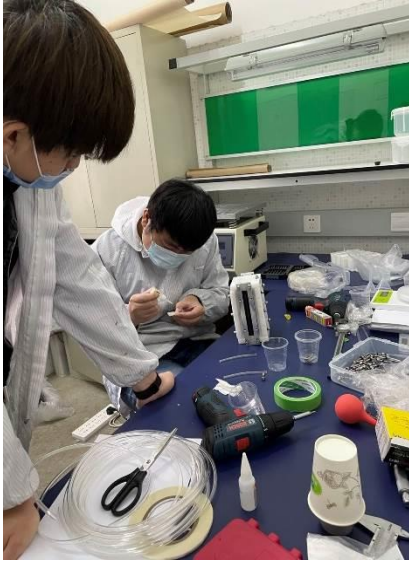
- 2668 fibres in one block

- 1600 kg in total

- 97% finished product ratio



Block Mass Production



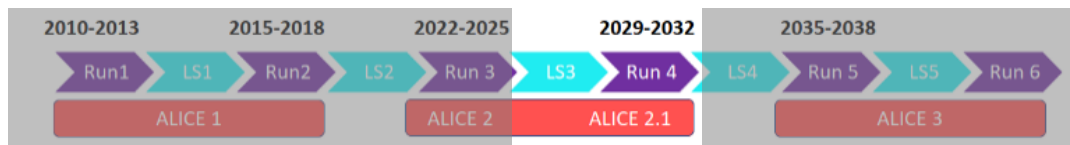
Block Mass Production



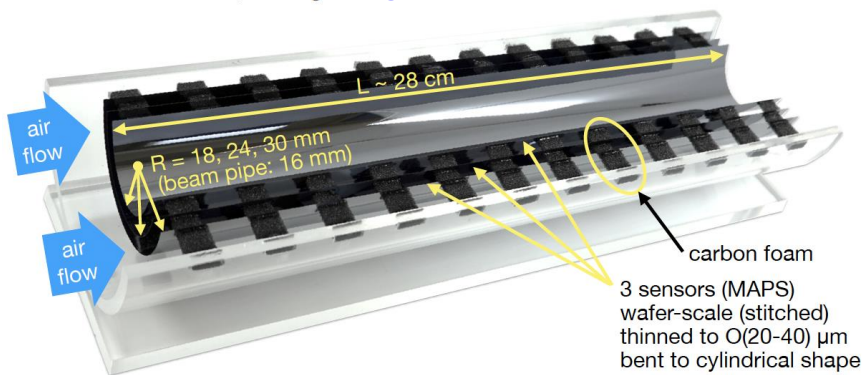
ALICE Upgrade



The ALICE 2.1

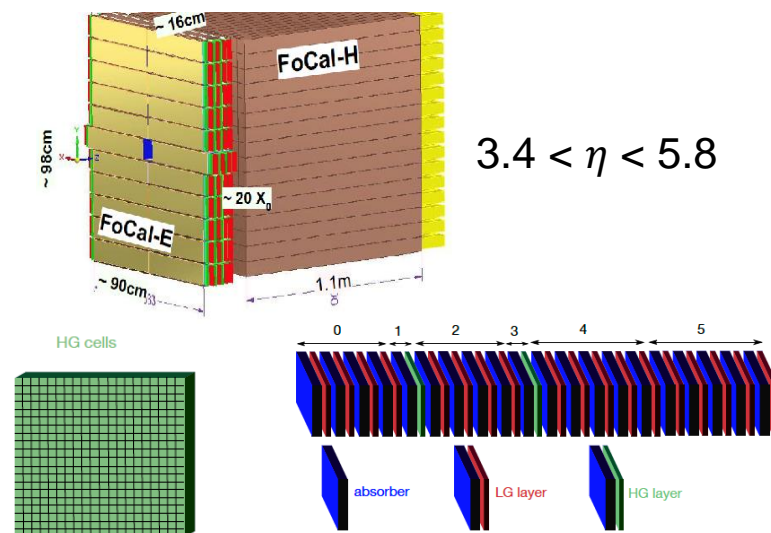


Stitching MAPS-based ITS3



- Replacement of 3 innermost layers of ITS2
- Curved **wafer-scale ultra-thin** silicon sensors: cylindrical layers (1 sensor per half layer)
- Low power \rightarrow air cooling \rightarrow low material budget
- Improved tracking precision and efficiency at low p_T

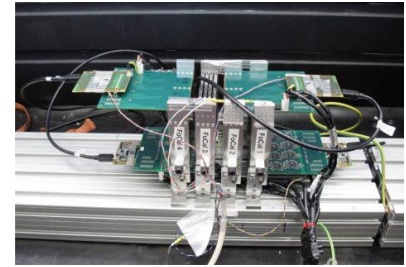
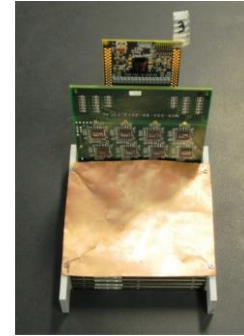
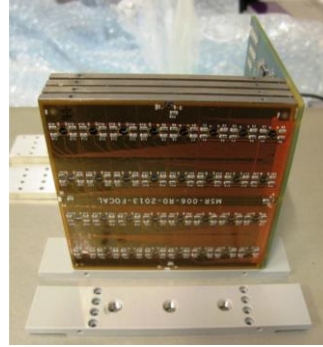
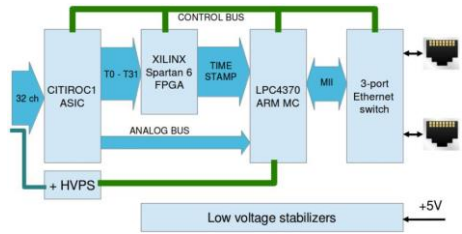
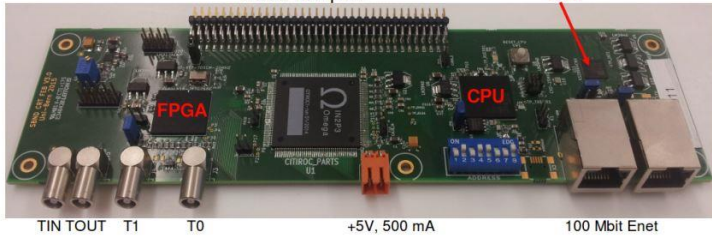
Silicon-based FoCal



- ✓ Pad (1×1 cm^2): shower profile and total energy
- ✓ Pixel (30×30 μm^2): position resolution to resolve overlapping showers

ALICE 2.1-Focal Readout Electronics

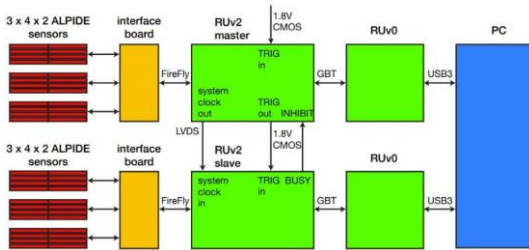
M. Auger et al 2016 JINST 11 P10005
32 SiPM inputs



arXiv:1912.11115

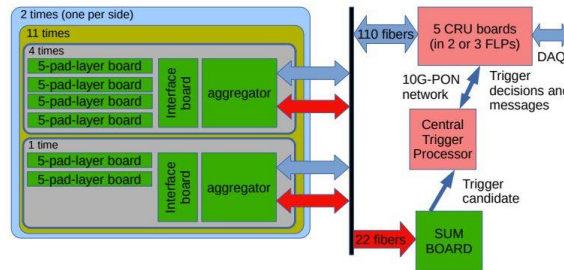
For the readout electronics of Focal-H, with a focus on the readout of the SiPM, a number of prototype electronics have been developed that use an ASIC as an analog front-end and an FPGA as a digital back-end. In the case of Focal-E, the electronics scheme chosen is also different due to the different granularity of the pad layer and the pixel layer.

FoCal-H 2021 prototype readout electronics

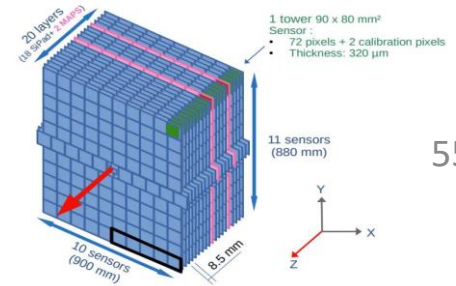


arXiv:2209.02511

FoCal-E pixel layer prototype EPICAL-2 readout electronics

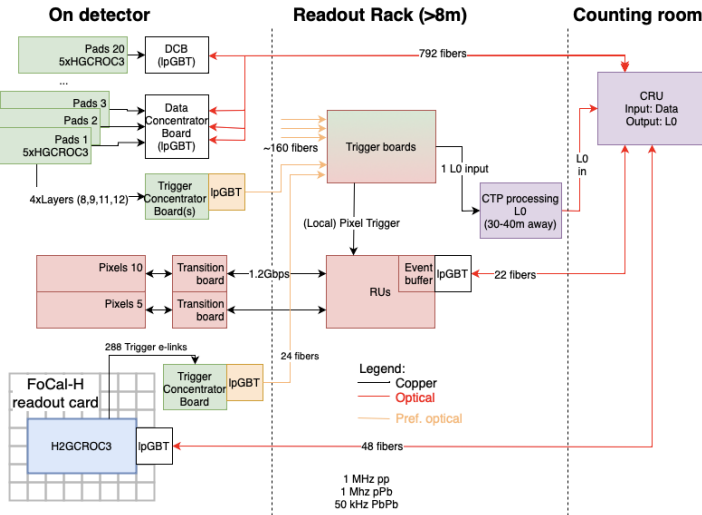


FoCal-E pad layer prototype readouts electronics



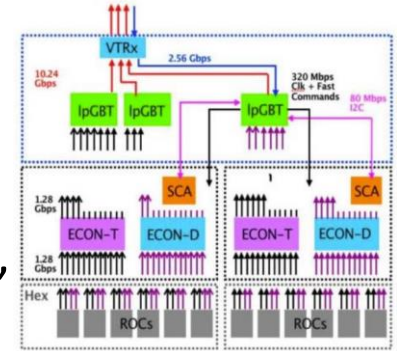
arXiv:2302.13912

ALICE 2.1-Focal Readout System

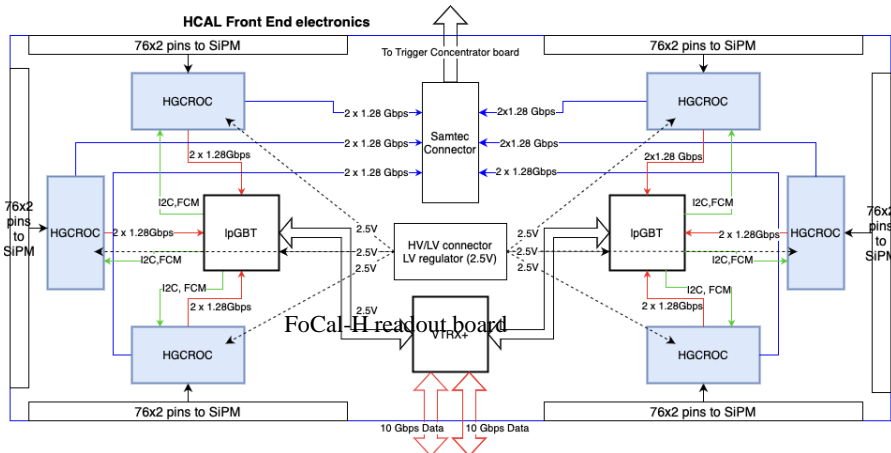


FoCal readout system

Focal Electronics' research borrowed part of the CMS design, and it is planned to use HGCROC as the front-end chip, IpGBT chip for data transmission, and FPGA for control.



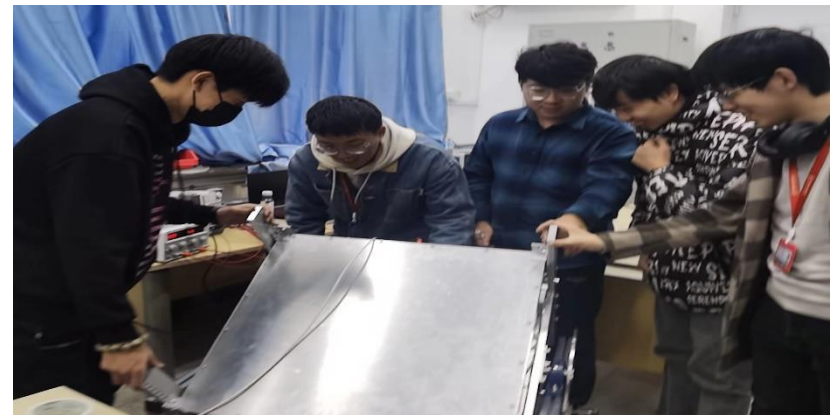
CMS CR -2021/228



- Protect FPGAs with Long Readout Rack
- Use ECON-D and IpGBT readout pixel data
- ALPIDE pixels use continuous trigger mode, or through signals provided by the Pad layer
- 6 HGCROC, 2 LpGBT, 1 VTRX+
- 6x72 = 432 channels
- Use ECON-D / ECON-T ASIC compress data

we have to make some improvements.

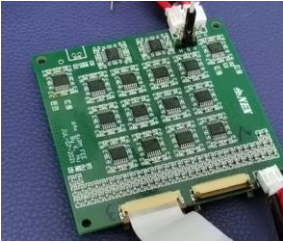
Scintillation Detector Array



Cosmic ray test



Detector



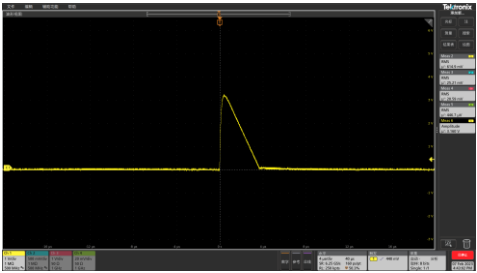
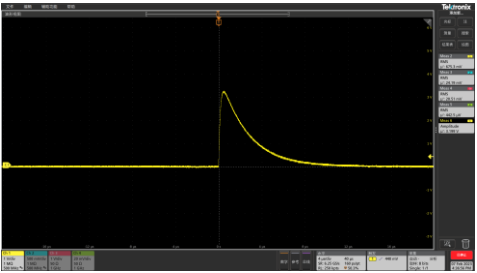
Analog Front End



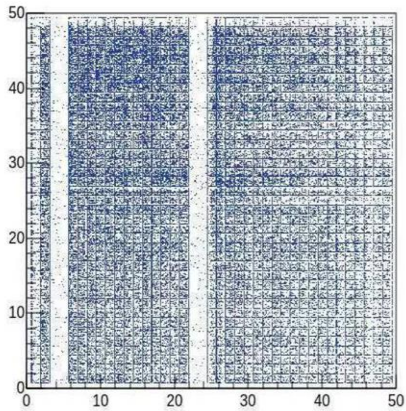
Digitalizer



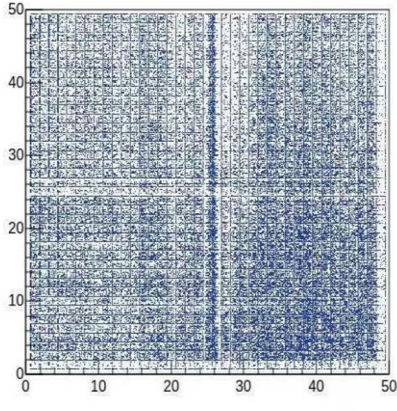
DAQ



Linear discharge test

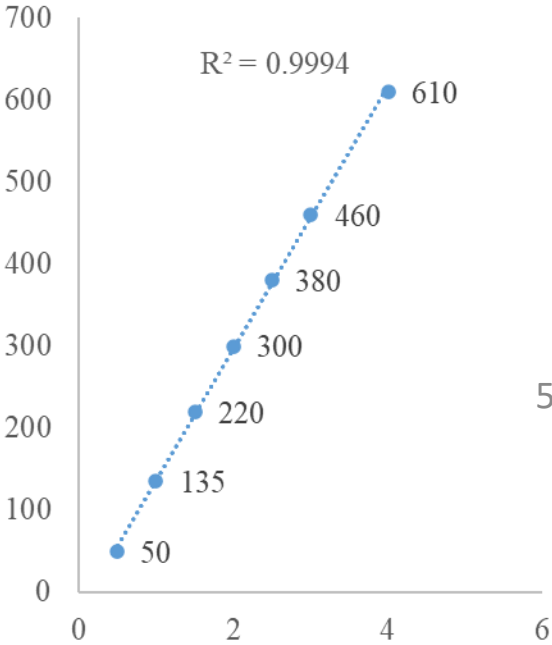


xyfit	
Entries	191683
Mean x	24.46
Mean y	25.60
Std Dev x	13.74
Std Dev y	14.05



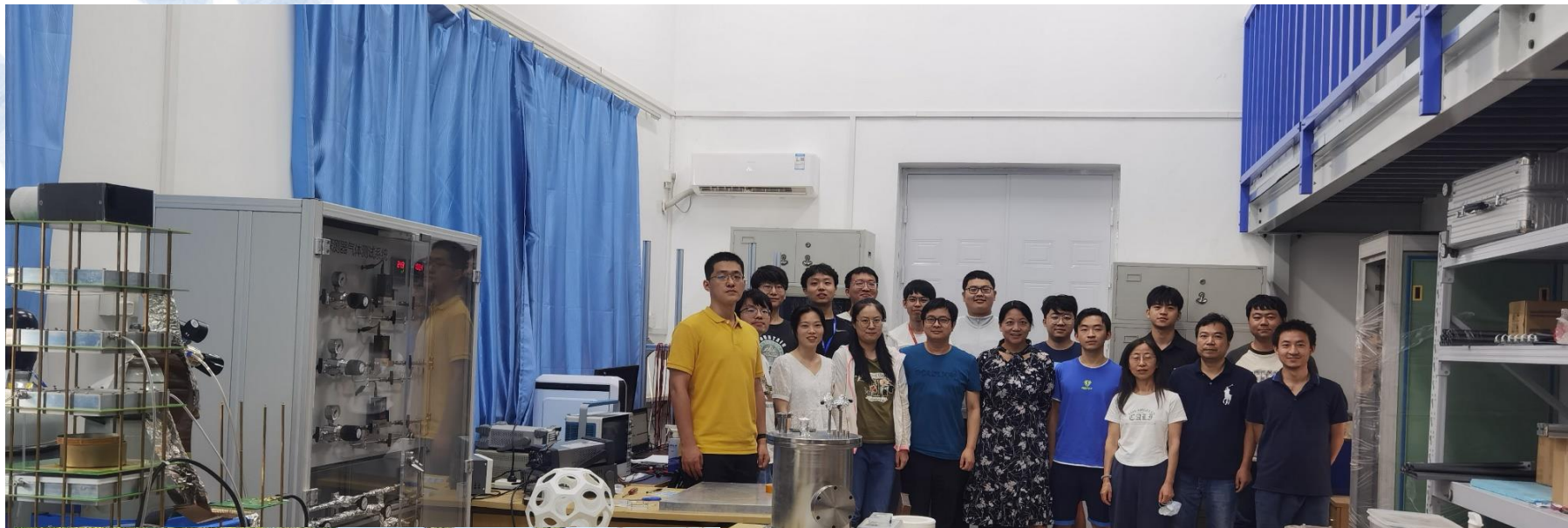
xyfit	
Entries	201408
Mean x	25.52
Mean y	24.45
Std Dev x	14.00
Std Dev y	14.01

cosmic ray event

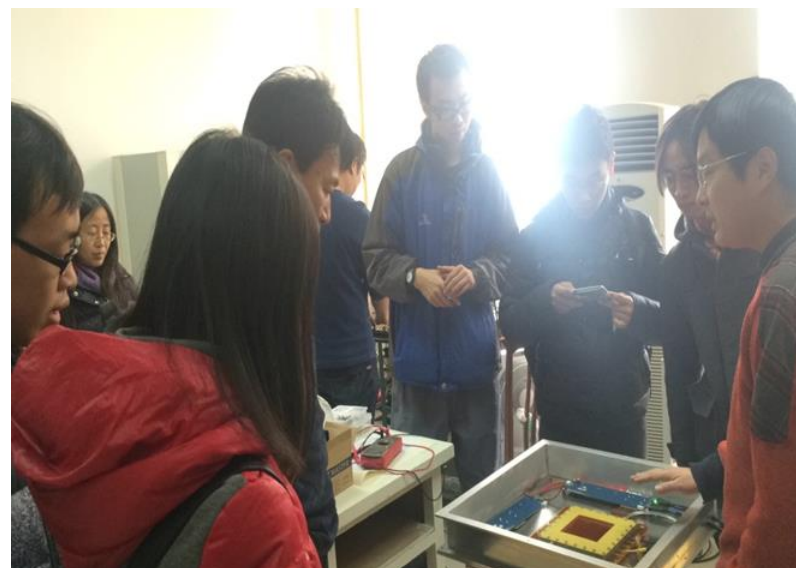


Linearity

Team Members



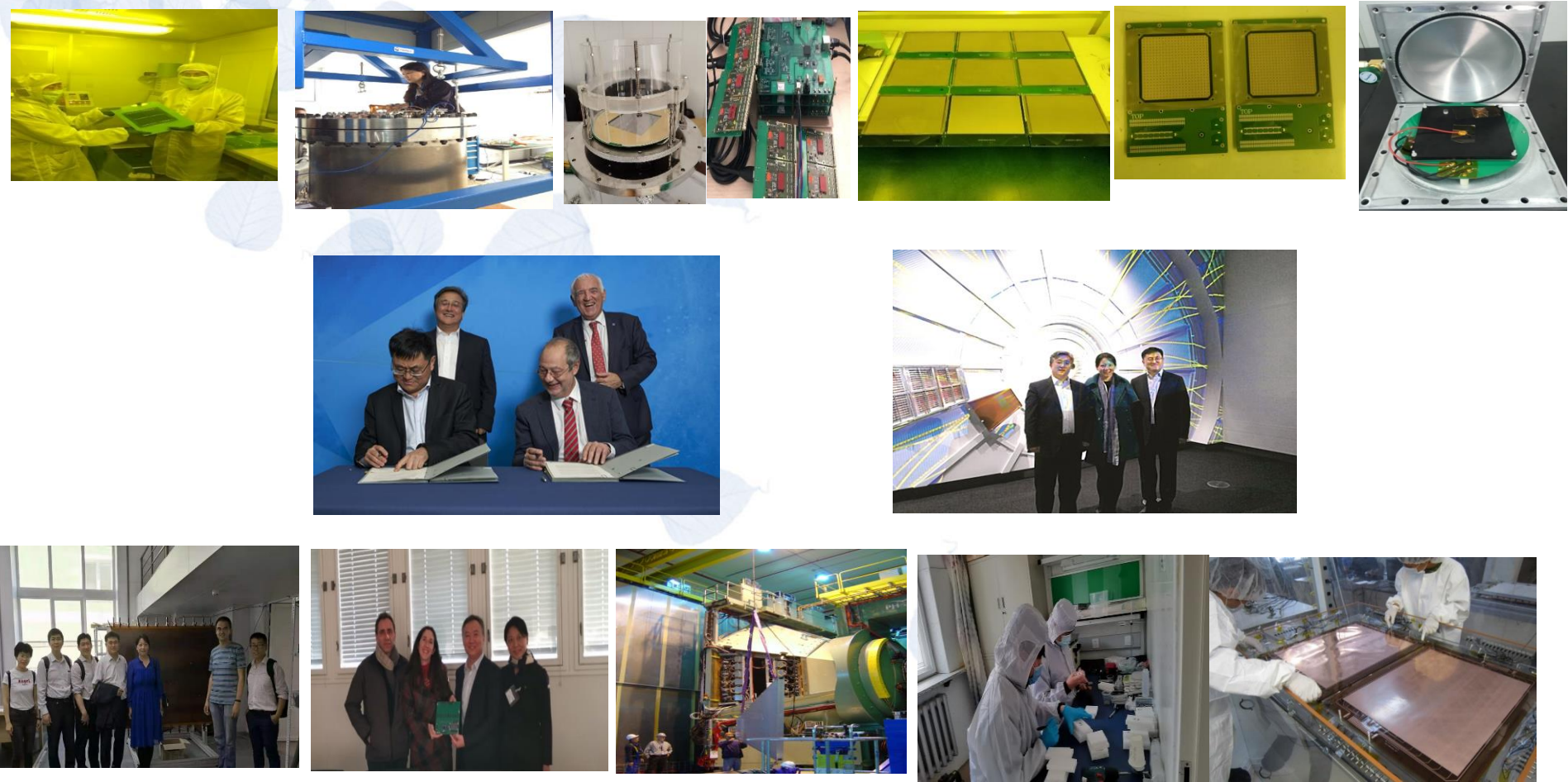
Visitors





Summary and Perspective

Current Applications and Collaborations



Thanks for your attention!

